

# Low Quiescent, High-Efficiency 3A ACOT<sup>®</sup> Synchronous Buck-Boost Converter with I<sup>2</sup>C Interface

## 1 General Description

The RT6160B is a high-efficiency, single-inductor, ACOT<sup>®</sup> (Advanced Constant On-Time) monolithic synchronous buck-boost converter that can deliver up to 3A output current from an input voltage range of 2.2V to 5.5V. It can regulate the digitally programmable output voltage from 2.025V to 5.2V, making it suitable for a wide range of input supply applications, regardless of whether the input voltage is lower, higher than, or equal to the output voltage. The ACOT<sup>®</sup> control architecture features outstanding line/load transient response, seamless transition between buck and boost modes, and provides stable operation with small ceramic output capacitors without the need for complicated external compensation.

The RT6160B features an I<sup>2</sup>C interface for programmable output voltage, ultra-sonic mode control, VOUT DVS slew-rate adjustment, and device status monitoring. The target output voltage can also be switched through the external VSEL pin to perform DVS (dynamic voltage scaling), and the ramp-up slew-rate and ramp mode of DVS can be set by configuring the related registers.

The RT6160B operates with automatic PFM (Pulse Frequency Modulation) mode, featuring a low quiescent current design of typically 3μA, maintaining high efficiency during light load operation.

At higher loads, the device automatically switches to a 2.2MHz fixed frequency control, effectively smoothing out the switching ripple voltage with small package filtering elements. The integrated low RDS(ON) power MOSFETs exhibit excellent efficiency under heavy load conditions. In shutdown mode, the supply current is typically 0.1μA, contributing to reduce power consumption. The PFM mode can be disabled if a fixed frequency is required. The RT6160B is housed in a compact WL-CSP-15B 1.4x2.3 (BSC) package.

The recommended junction temperature range is -40°C to 125°C, and the ambient temperature range is -40°C to 85°C.

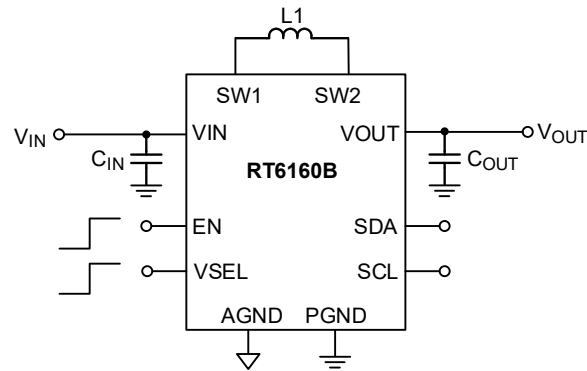
## 2 Features

- Automatic Seamless Mode Transition with Real Buck, Buck-Boost, and Boost Operation
- Input Voltage Range: 2.2V to 5.5V
- Output Voltage Range: 2.025V to 5.2V with Digitally Programmable Steps (25mV/steps)
- Default Output Voltage Settings:
  - VOUT = 3.3V at VSEL = L
  - VOUT = 3.85V at VSEL = H
- Maximum Continuous Output Current:
  - Up to 2.5A for VIN ≥ 2.5V, VOUT = 3.3V
  - Up to 3A for VIN ≥ 3V, VOUT = 3.3V
  - Up to 2A for VIN ≥ 3V, VOUT = 5V
- Up to 95% Efficiency (VIN = 3.8V, VOUT = 3.3V, ILOAD = 1A)
- 2μA Non-Switching Low Quiescent Current
- I<sup>2</sup>C Interface (up to 1MHz)
- Allow Dynamically-Voltage-Scaling Control
- Automatic PFM Mode and Forced PWM Mode Selection
- Ultra-Sonic Mode Operation
- Protections: OCP, UVLO, OTP, OVP, UVP
- 15-Ball WL-CSP Package

## 3 Applications

- Smartphones and Tablets
- Portable Devices
- Wearable Devices
- System Pre-Regulators
- Point-of-Load Regulators
- Wi-Fi Modules
- USB VCONN Supplies
- TWS Earbud Chargers

## 4 Simplified Application Circuit



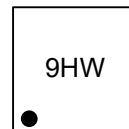
## 5 Ordering Information

RT6160B □  
**Package Type**<sup>(1)</sup>  
 WSC: WL-CSP-15B 1.4x2.3 (BSC)

### Note 1.

Richtek products are Richtek Green Policy compliant and marked with <sup>(1)</sup> indicates compatible with the current requirements of IPC/JEDEC J-STD-020.

## 6 Marking Information

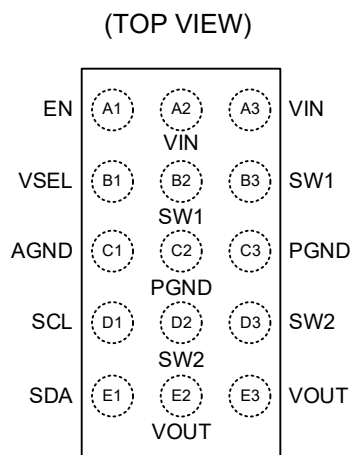


9H: Product Code  
 W: Date Code

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## 7 Pin Configuration

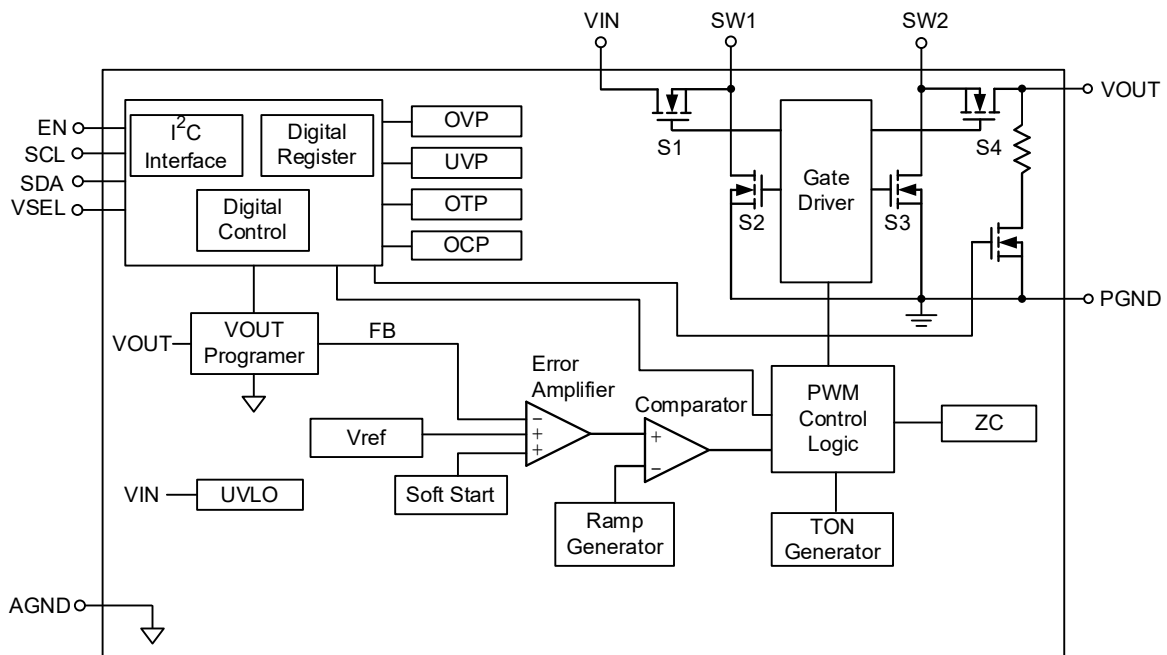


WL-CSP-15B 1.4x2.3 (BSC)

## 8 Functional Pin Description

| Pin No. | Pin Name | Pin Function   |
|---------|----------|--|
| A1      | EN       | Enable control input. A logic-high enables the converter; a logic-low forces the device into shutdown mode.  |
| A2, A3  | VIN      | Power input. The input voltage range is from 2.2V to 5.5V after the soft-start is finished. Connect input capacitors between this pin and PGND with minimal path. It is recommended to use a 10 $\mu$ F/6.3V/X5R/0402 and a 0.1 $\mu$ F/6.3V/X5R/0201 ceramic capacitor. |
| B1      | VSEL     | Voltage select pin. When this pin is grounded, VOUT is set by the VOUT1 register; when tied to logic-high, VOUT is set by the VOUT2 register.  |
| B2, B3  | SW1      | Switching node 1. Connect to the inductor.   |
| C1      | AGND     | Analog ground. All signals are referenced to this pin. Avoid routing high dV/dt AC currents through this pin.  |
| C2, C3  | PGND     | Power ground. The low-side MOSFET is referenced to this pin. C <sub>IN</sub> and C <sub>OUT</sub> should be returned with a minimal path to these pins.  |
| D1      | SCL      | I <sup>2</sup> C serial interface clock. This pin requires a pull-up resistor to I <sup>2</sup> C power supply.  |
| D2, D3  | SW2      | Switching node 2. Connect to the inductor.   |
| E1      | SDA      | I <sup>2</sup> C serial interface data. This pin requires a pull-up resistor to I <sup>2</sup> C power supply.   |
| E2, E3  | VOUT     | Output voltage sense through this pin. Connect to the output capacitor. It is recommended to use two 22 $\mu$ F/10V/X5R/0603 ceramic capacitors.   |

## 9 Functional Block Diagram



## 10 Absolute Maximum Ratings

(Note 2)

|  |       |                |
|--|-------|----------------|
| • Input Voltage, VIN                           | ----- | -0.3V to 6V    |
| • Output Voltage, VOUT                         | ----- | -0.3V to 6.2V  |
| • Switch Node Voltage, SW1, SW2                |       |                |
| DC   | ----- | -0.3V to 6V    |
| AC (<50ns)                                     | ----- | -5V to 8.5V    |
| • Other I/O Pins Voltages (EN, VSEL, SCL, SDA) | ----- | -0.3V to 6V    |
| • Power Dissipation, PD @ TA = 25°C            |       |                |
| WL-CSP-15B 1.4x2.3 (BSC)                       | ----- | 1.88W          |
| • Package Thermal Resistance (Note 3)          |       |                |
| WL-CSP-15B 1.4x2.3 (BSC), $\theta_{JA}$        | ----- | 53°C/W         |
| • Junction Temperature                         | ----- | 150°C          |
| • Lead Temperature (Soldering, 10 sec.)        | ----- | 260°C          |
| • Storage Temperature Range                    | ----- | -65°C to 150°C |
| • ESD Susceptibility (Note 4)                  |       |                |
| HBM (Human Body Model)                         | ----- | 2kV            |

**Note 2.** Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

**Note 3.**  $\theta_{JA}$  is measured under natural convection (still air) at  $T_A = 25^\circ\text{C}$  with the component mounted on a high effective-thermal-conductivity four-layer test board on a JEDEC 51-7 thermal measurement standard.

**Note 4.** Devices are ESD sensitive. Handling precautions are recommended.

## 11 Recommended Operating Conditions

(Note 5)

|                                     |       |  |
|-------------------------------------|-------|--|
| • Input Voltage, VIN                | ----- | 2.2V to 5.5V                             |
| • Output Voltage, VOUT              | ----- | 2.025V to 5.2V                           |
| • Output Current, IOUT              | ----- | 0A to 3A                                 |
| • Input Capacitance, CIN (Note 6)   | ----- | 5 $\mu\text{F}$ (Minimum)                |
| • Output Capacitance, COUT (Note 6) | ----- | 16 $\mu\text{F}$ (Minimum)               |
| • Inductance, L                     | ----- | 0.39 $\mu\text{H}$ to 0.56 $\mu\text{H}$ |
| • Ambient Temperature Range         | ----- | -40°C to 85°C                            |
| • Junction Temperature Range        | ----- | -40°C to 125°C                           |

**Note 5.** The device is not guaranteed to function outside its operating conditions.

**Note 6.** Effective capacitance after DC bias effects have been considered.

## 12 Electrical Characteristics

( $V_{IN} = 3.6V$ ,  $V_{OUT} = 3.3V$ ,  $T_A = T_J = 25^{\circ}C$ , unless otherwise specified.)

| Parameter                                 | Symbol        | Test Conditions                                | Min   | Typ  | Max  | Unit       |
|---|---------------|--|-------|------|------|------------|
| VIN Supply Input Voltage                  | VIN           |  | 2.2   | --   | 5.5  | V          |
| Undervoltage-Lockout Rising Threshold     | VUVLO_R       | VIN rising                                     | 2.11  | 2.14 | 2.19 | V          |
| Undervoltage-Lockout Falling Threshold    | VUVLO_F       | VIN falling                                    | 2.02  | 2.05 | 2.08 | V          |
| Undervoltage-Lockout Hysteresis           | VUVLO_HYS     |  | --    | 90   | --   | mV         |
| Quiescent Current (Switching Current)     | IQ_SW         | VEN = VIN = 3.6V, IOUT = 0A                    | --    | 3    | 6    | $\mu A$    |
| Quiescent Current (Non-Switching Current) | IQ_NSW        | VEN = VIN = 3.6V, IOUT = 0A, not switching     | --    | 2    | 4    |            |
| Shutdown Current                          | ISHDN         | VEN = 0V, VIN = 3.6V                           | --    | 0.1  | 1    | $\mu A$    |
| High-Level Input Current                  | IiH           | VSCL = VSDA = VSEL = 1.8V, no pull-up resistor | --    | --   | 0.1  | $\mu A$    |
| Low-Level Input Current                   | IiL           | VSCL = VSDA = VSEL = 0V, no pull-up resistor   | --    | --   | 0.1  | $\mu A$    |
| Input Bias Current                        | IBIAS         | VEN = 0 to 5.5V                                | --    | --   | 0.1  | $\mu A$    |
| High-Side MOSFET Leakage Current          | I_LK_H        | VEN = 0V, VSW = 0V                             | --    | 1    | --   | $\mu A$    |
| On-Resistance of High-Side MOSFET         | RDSON_H       |  | --    | 25   | --   | m $\Omega$ |
| On-Resistance of Low-Side MOSFET          | RDSON_L       |  | --    | 38   | --   | m $\Omega$ |
| Output Discharge Resistor                 | RDISCHG       | VEN = 0V                                       | --    | 5    | --   | $\Omega$   |
| EN Input Voltage Rising threshold         | VEN_R         | VIN = 2.2V to 5.5V                             | 1.2   | --   | --   | V          |
| EN Input Voltage Falling threshold        | VEN_F         | VIN = 2.2V to 5.5V                             | --    | --   | 0.4  | V          |
| Input Voltage Logic-High (SCL, SDA, VSEL) | VIH           |  | 1.2   | --   | --   | V          |
| Input Voltage Logic-Low (SCL, SDA, VSEL)  | VIL           |  | --    | --   | 0.4  |            |
| Output Voltage Range                      | VOUT_RANGE    |  | 2.025 | --   | 5.2  | V          |
| Default Output Voltage (VSEL = L)         | VOUT_SEL_L    | VSEL = low                                     | --    | 3.3  | --   | V          |
| Default Output Voltage (VSEL = H)         | VOUT_SEL_H    | VSEL = high                                    | --    | 3.85 | --   |            |
| Output Voltage Accuracy (FPWM)            | VOUT_ACC_FPWM | Forced PWM operation                           | -1    | --   | 1    | %          |
| Output Voltage Accuracy (AUTO)            | VOUT_ACC_AUTO | Auto PFM operation                             | -1    | --   | 3    |            |
| Output Voltage Accuracy (USC)             | VOUT_ACC_USC  | Ultra-Sonic operation                          | -1    | --   | 3    |            |
| Line Regulation                           | VLINE_REG     | ( <a href="#">Note 7</a> )                     | --    | 0.5  | --   | %          |
| Load Regulation                           | VLOAD_REG     | ( <a href="#">Note 7</a> )                     | --    | 0.5  | --   | %          |

| Parameter                              | Symbol                  | Test Conditions  | Min | Typ | Max | Unit |
|--|-------------------------|--|-----|-----|-----|------|
| Maximum Continuous Output Current      | I <sub>MAX</sub>        | V <sub>IN</sub> ≥ 2.5V, V <sub>OUT</sub> = 3.3V, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF (Note 8)  | 2.5 | --  | --  | A    |
|  |                         | V <sub>IN</sub> ≥ 3V, V <sub>OUT</sub> = 3.3V, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF (Note 8)  | 3   | --  | --  |      |
| High-Side Switch (Peak) Current Limit  | I <sub>LIM_H</sub>      | V <sub>IN</sub> = 3.6V, V <sub>OUT</sub> = 3.3V  | 4.5 | 5   | 5.5 | A    |
| Low-Side Switch (Valley) Current Limit | I <sub>LIM_L</sub>      | V <sub>IN</sub> = 3.6V, V <sub>OUT</sub> = 3.3V  | 4   | 4.5 | 5   | A    |
| PFM to PWM Threshold Inductor Current  | I <sub>L_T_PFM</sub>    | V <sub>IN</sub> = 3.6V, V <sub>OUT</sub> = 3.3V, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF   | --  | 0.3 | --  | A    |
| Efficiency                             | η                       | V <sub>IN</sub> = 3.3V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 0.1A, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF, Auto PFM operation          | --  | 95  | --  | %    |
|  |                         | V <sub>IN</sub> = 3.3V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 1A, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF, Forced PWM operation          | --  | 94  | --  |      |
|  |                         | V <sub>IN</sub> = 3.8V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 0.1A, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF, Auto PFM operation          | --  | 94  | --  |      |
|  |                         | V <sub>IN</sub> = 3.8V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 1A, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF, Forced PWM operation          | --  | 95  | --  |      |
| Output Ripple Voltage                  | V <sub>OUT_RIPPLE</sub> | V <sub>IN</sub> = 3.3V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 0.1A, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF, Auto PFM operation (Note 7) | --  | 50  | --  | mV   |
|  |                         | V <sub>IN</sub> = 3.3V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 1A, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF, Forced PWM operation (Note 7) | --  | 20  | --  |      |
|  |                         | V <sub>IN</sub> = 3.8V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 0.1A, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF, Auto PFM operation (Note 7) | --  | 25  | --  |      |
|  |                         | V <sub>IN</sub> = 3.8V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 1A, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF, Forced PWM operation (Note 7) | --  | 10  | --  |      |



| Parameter  | Symbol                | Test Conditions   | Min  | Typ | Max  | Unit |
|--|-----------------------|---|------|-----|------|------|
| Load Transient Response                          | V <sub>LOAD_TR</sub>  | V <sub>IN</sub> = 3.8V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 0.05A to 1A, t <sub>R</sub> = t <sub>F</sub> = 1μs (Note 7)   | –100 | --  | 100  | mV   |
|  |                       | V <sub>IN</sub> = 3.8V, V <sub>OUT</sub> = 3.3V, I <sub>OUT</sub> = 0.05A to 0.5A, t <sub>R</sub> = t <sub>F</sub> = 1μs (Note 7) | –50  | --  | 50   |      |
| Line Transient Response                          | V <sub>LINE_TR</sub>  | I <sub>OUT</sub> = 1A, V <sub>IN</sub> = 3V to 3.6V to 3V, t <sub>R</sub> = t <sub>F</sub> = 10μs (Note 7)                        | –50  | --  | 50   | mV   |
| Switching Frequency                              | f <sub>SW</sub>       | Boost or Buck operation   | --   | 2.2 | --   | MHz  |
| Switching Frequency Range                        | f <sub>SW_RANGE</sub> | Forced PWM operation, I <sub>OUT</sub> = 100mA  | 0.5  | --  | 3    | MHz  |
| Switching Frequency at Ultra-Sonic Mode          | f <sub>SW_USC</sub>   | I <sub>OUT</sub> = 1mA  | 30   | --  | --   | kHz  |
| Minimum On-Time                                  | t <sub>ON_MIN</sub>   |   | 20   | --  | 60   | ns   |
| Minimum Off-Time                                 | t <sub>OFF_MIN</sub>  |   | 20   | --  | 60   | ns   |
| Output Voltage Rising Time<br>Turn-On Rise Time  | t <sub>R</sub>        | Output voltage ramp to output voltage 95%, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF                            | --   | 300 | 1000 | μs   |
| Enable Delay Time                                | t <sub>DLY_EN</sub>   | Enable pin logic-high to output voltage ramp, L = 0.47μH, C <sub>IN</sub> = 10μF, C <sub>OUT</sub> = 44μF                         | --   | 220 | 300  | μs   |
| VSEL Delay Time                                  | t <sub>DLY_VSEL</sub> | Delay between the rising edge of VSEL and the start of the DVS ramp   | --   | 30  | --   | μs   |
| Output Undervoltage Rising Threshold             | V <sub>UVP_R</sub>    |   | --   | 95  | --   | %    |
| Output Undervoltage Falling Threshold            | V <sub>UVP_F</sub>    |   | --   | 90  | --   | %    |
| Output Voltage Dynamic Voltage Scaling Slew Rate | DVS <sub>SR</sub>     | 0x01, bit[1:0] = 00b  | 0.8  | 1   | 1.2  | V/ms |
|  |                       | 0x01, bit[1:0] = 01b  | 2    | 2.5 | 3    |      |
|  |                       | 0x01, bit[1:0] = 10b  | 4    | 5   | 6    |      |
|  |                       | 0x01, bit[1:0] = 11b  | 8    | 10  | 12   |      |
| Over-Temperature Protection Threshold            | T <sub>OTP</sub>      | (Note 7)  | 140  | 150 | 160  | °C   |
| Over-Temperature Protection Hysteresis           | T <sub>OTP_HYS</sub>  | (Note 7)  | --   | 20  | --   | °C   |

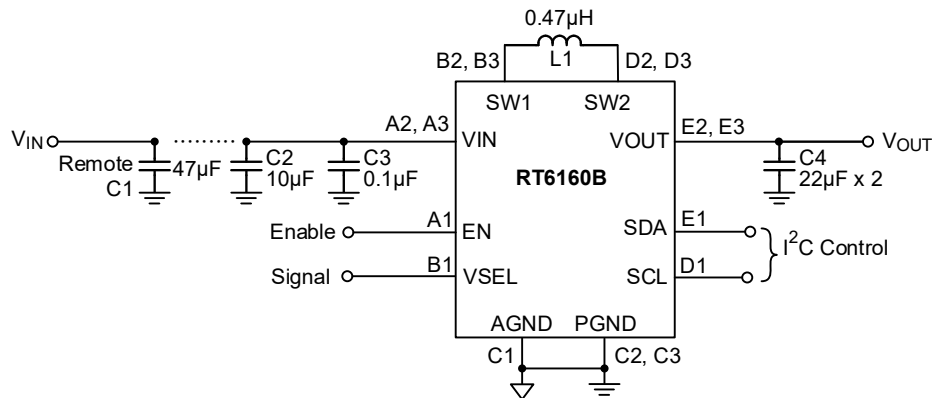
**Note 7.** Guaranteed by design.

**Note 8.** The device can sustain the maximum recommended output current. Users must verify that the thermal performance of the end application can support the maximum output current.

12.1 I<sup>2</sup>C Characteristics

| Parameter                                       | Symbol               | Test Conditions | Min  | Typ | Max  | Unit |
|---|----------------------|-----------------|------|-----|------|------|
| Logic Output Threshold Voltage (SCL, SDA, VSEL) | V <sub>IO_I2C</sub>  |                 | --   | --  | 0.4  | V    |
| I <sup>2</sup> C Work Voltage                   | V <sub>INT_I2C</sub> |                 | --   | 1.8 | --   | V    |
| Input Current Each IO Pin                       | I <sub>IN_I2C</sub>  |                 | -10  | --  | 10   | μA   |
| SDA Setup Time                                  | t <sub>SU;DAT</sub>  |                 | 70   | --  | --   | ns   |
| SCL Clock Frequency                             | f <sub>SCL</sub>     | Standard mode   | --   | --  | 100  | kHz  |
|   |                      | Fast mode       | --   | --  | 400  |      |
|   |                      | Fast mode plus  | --   | --  | 1000 |      |
| Bus Free Time between Stop and Start            | t <sub>BUF</sub>     | Standard mode   | 4.7  | --  | --   | μs   |
|   |                      | Fast mode       | 1.3  | --  | --   |      |
|   |                      | Fast mode plus  | 0.5  | --  | --   |      |
| (Repeated) Start Hold Time                      | t <sub>HD;STA</sub>  | Standard mode   | 4.7  | --  | --   | μs   |
|   |                      | Fast mode       | 0.6  | --  | --   |      |
|   |                      | Fast mode plus  | 0.26 | --  | --   |      |
| (Repeated) Start Setup Time                     | t <sub>SU;STA</sub>  | Standard mode   | 4.7  | --  | --   | μs   |
|   |                      | Fast mode       | 0.6  | --  | --   |      |
|   |                      | Fast mode plus  | 0.26 | --  | --   |      |
| SDA Data Hold Time                              | t <sub>HD;DAT</sub>  | Standard mode   | 0.1  | --  | --   | ns   |
|   |                      | Fast mode       | 0.1  | --  | --   |      |
|   |                      | Fast mode plus  | 0.1  | --  | --   |      |
| STOP Condition Setup Time                       | t <sub>SU;STO</sub>  | Standard mode   | 4    | --  | --   | μs   |
|   |                      | Fast mode       | 0.6  | --  | --   |      |
|   |                      | Fast mode plus  | 0.26 | --  | --   |      |
| SDA Valid Acknowledge Time                      | t <sub>VD;ACK</sub>  | Standard mode   | --   | --  | 3.45 | μs   |
|   |                      | Fast mode       | --   | --  | 0.9  |      |
|   |                      | Fast mode plus  | --   | --  | 0.45 |      |
| SDA Setup Time                                  | t <sub>SU;DAT</sub>  | Standard mode   | 250  | --  | --   | ns   |
|   |                      | Fast mode       | 100  | --  | --   |      |
|   |                      | Fast mode plus  | 50   | --  | --   |      |
| SCL Clock Low Period                            | t <sub>LOW</sub>     | Standard mode   | 4.7  | --  | --   | μs   |
|   |                      | Fast mode       | 1.3  | --  | --   |      |
|   |                      | Fast mode plus  | 0.5  | --  | --   |      |
| SCL Clock High Period                           | t <sub>HIGH</sub>    | Standard mode   | 4    | --  | --   | μs   |
|   |                      | Fast mode       | 0.6  | --  | --   |      |
|   |                      | Fast mode plus  | 0.26 | --  | --   |      |

### 13 Typical Application Circuit



**Table 1. Recommended Components Information** (Note 9)

| Reference       | Part Number       | Description    | Package   | Manufacturer |
|-----------------|-------------------|----------------|-----------|--------------|
| C1<br>(Note 10) | GRM32ER61C476KE15 | 47µF/16V/X5R   | 1210      | Murata       |
| C2              | GRM155R60J106ME15 | 10µF/6.3V/X5R  | 0402      | Murata       |
| C3<br>(Note 11) | GRM033R60J104KE19 | 0.1µF/6.3V/X5R | 0201      | Murata       |
| C4              | GRM188R61A226ME15 | 22µF/10V/X5R   | 0603      | Murata       |
| L1              | XFL4015-471MEC    | 0.47µH         | 4x4x1.5mm | Coilcraft    |

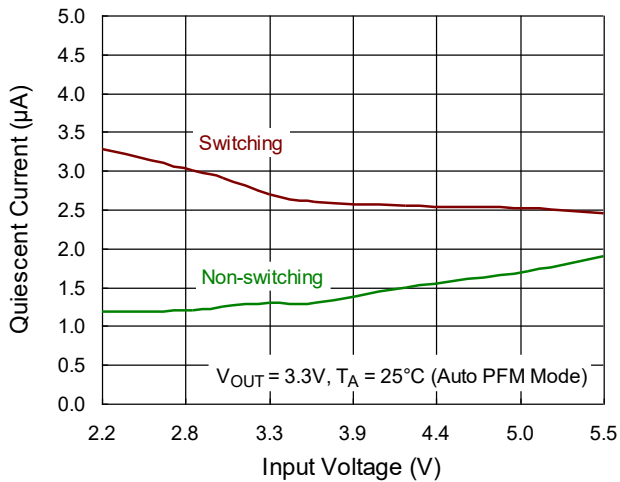
**Note 9.** All the input and output capacitors are the suggested values, referring to the effective capacitances, subject to any de-rating effects, such as DC bias.

**Note 10.** The decoupling capacitor C1 is a remote C<sub>OUT</sub> capacitor. C1 is optional. The device is designed to operate with a DC supply voltage in the range of 2.2V to 5.5V. If the input supply is more than a few centimeters from the device, it is recommended to add some bulk capacitance to the ceramic bypass capacitors. A 47µF electrolytic capacitor is a typical selection for the bulk capacitance.

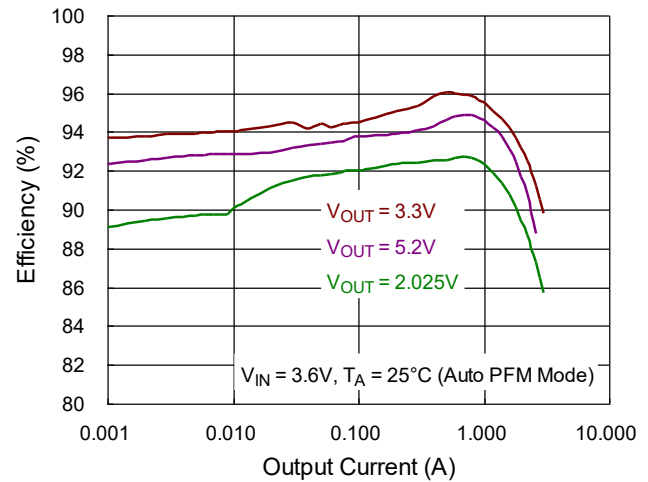
**Note 11.** The decoupling capacitor C3 is recommended to reduce any high-frequency components on the VIN bus. C3 is optional and used to filter any high-frequency components on the VIN bus.

## 14 Typical Operating Characteristics

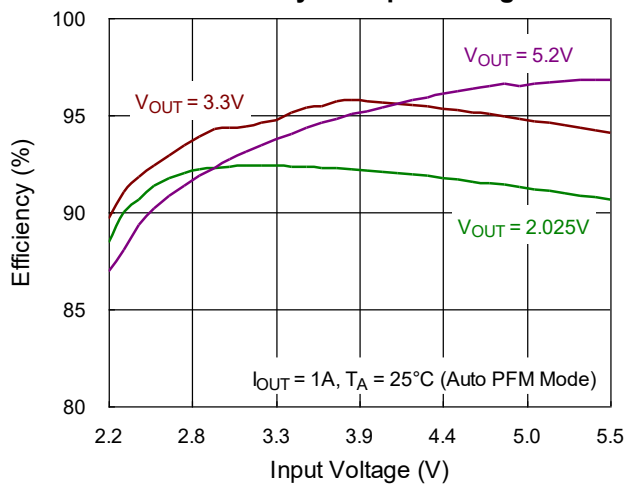
Quiescent Current vs. Input Voltage



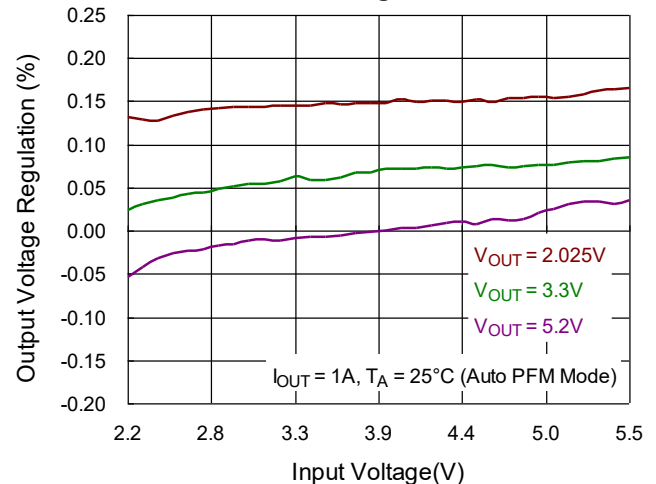
Efficiency vs. Output Current



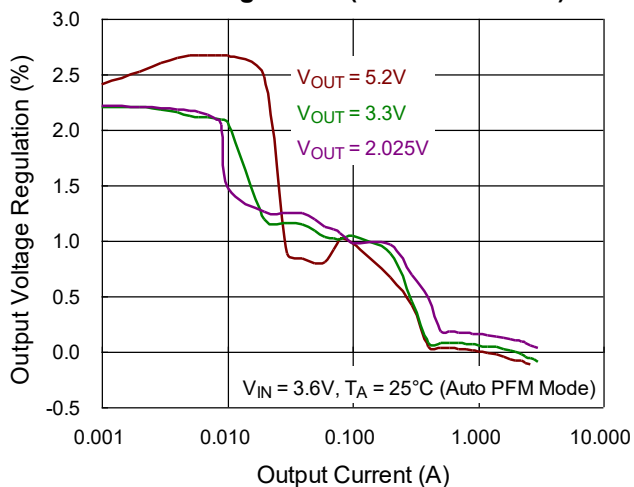
Efficiency vs. Input Voltage



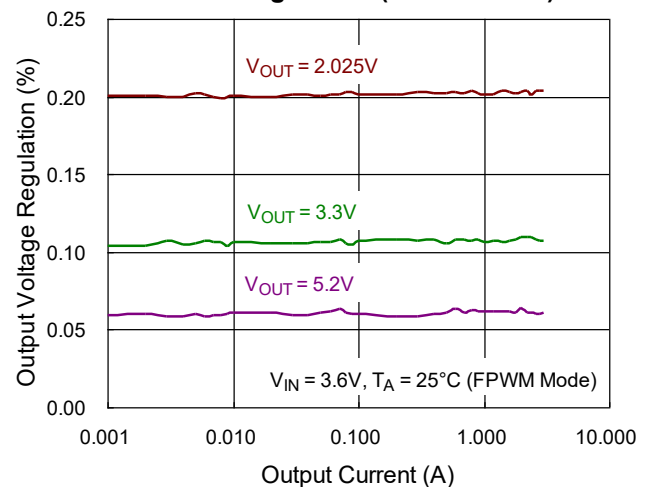
Line Regulation



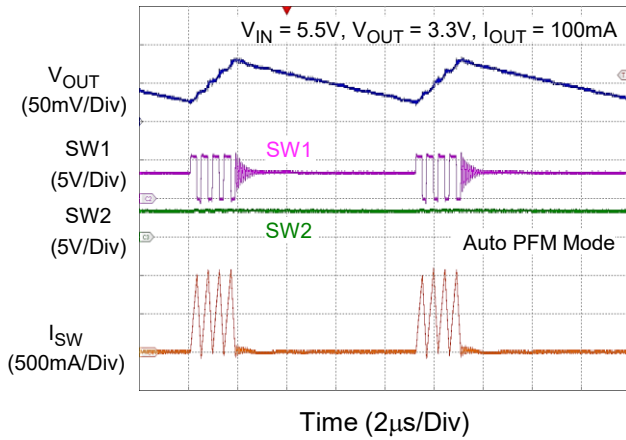
Load Regulation (Auto PFM Mode)



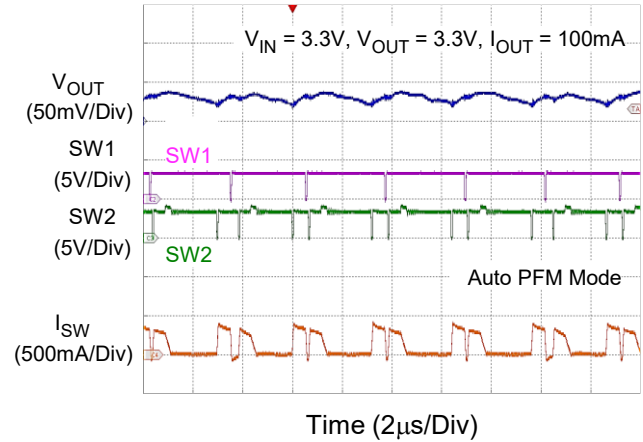
Load Regulation (FPWM Mode)



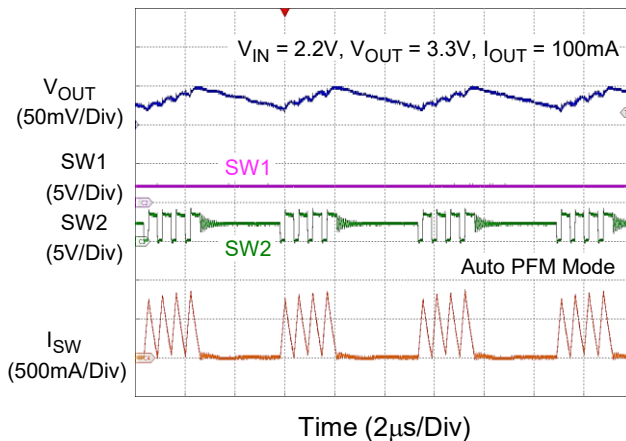
**PFM Switching Waveforms  
(Buck Operation)**



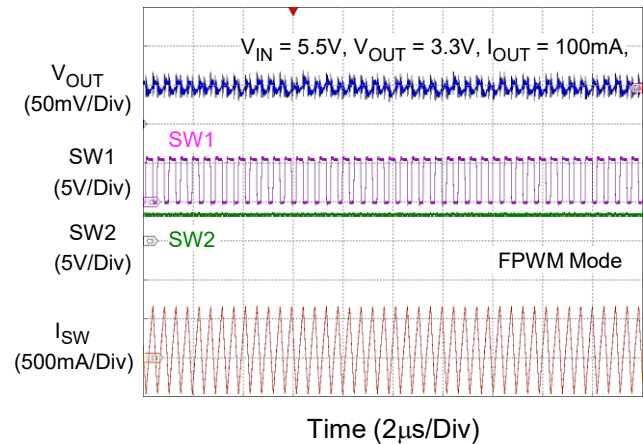
**PFM Switching Waveforms  
(Buck-Boost Operation)**



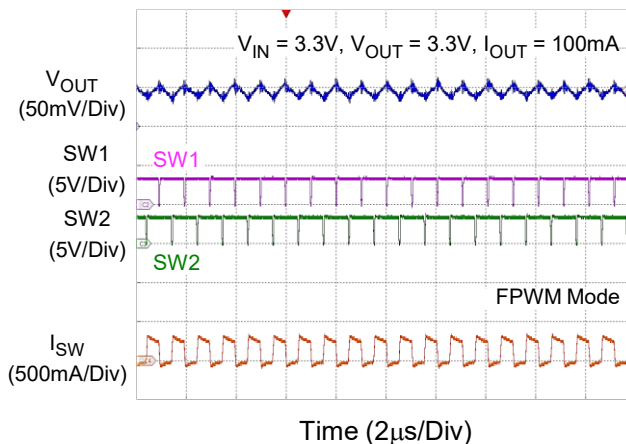
**PFM Switching Waveforms  
(Boost Operation)**



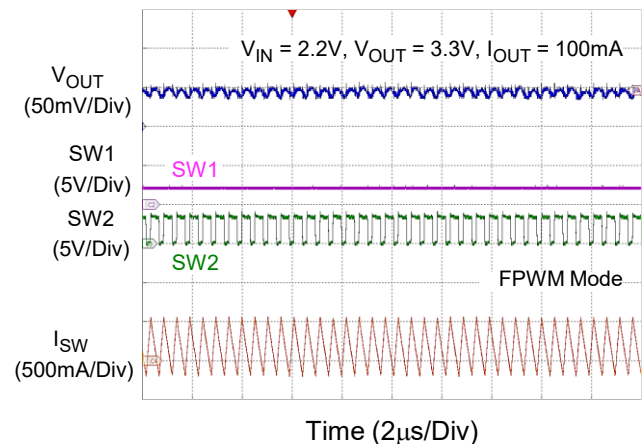
**PWM Switching Waveforms  
(Buck Operation)**



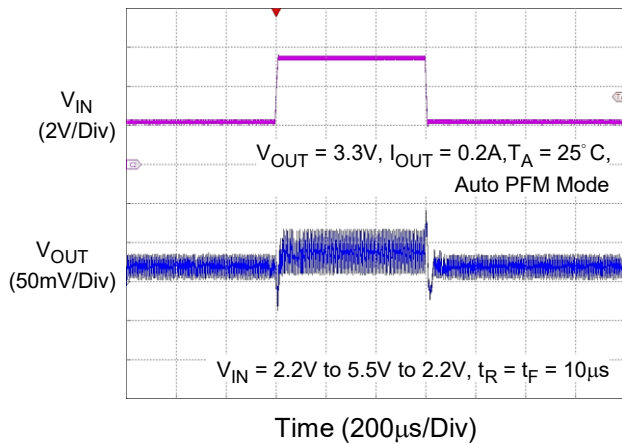
**PWM Switching Waveforms  
(Buck-Boost Operation)**



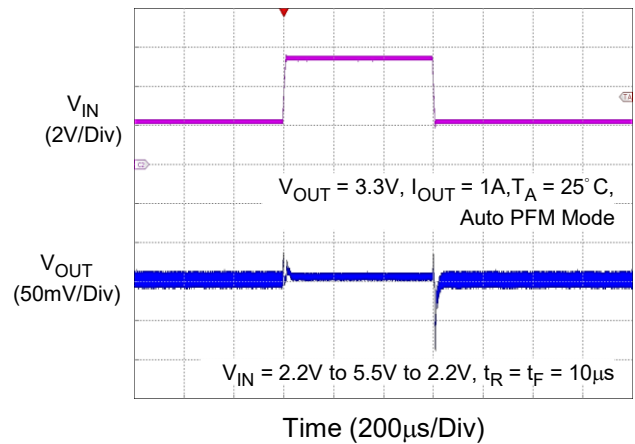
**PWM Switching Waveforms  
(Boost Operation)**



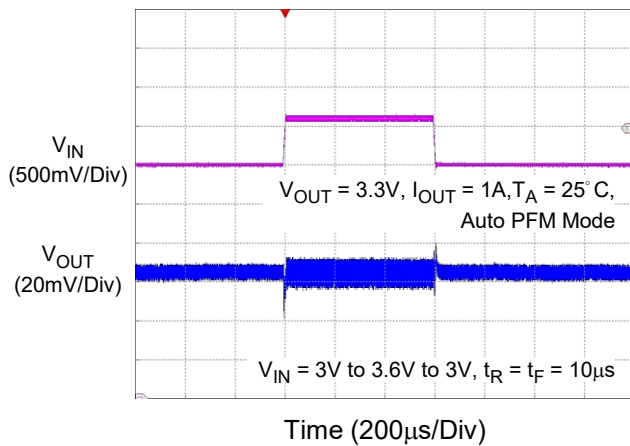
Line Transient Response (Light Load)



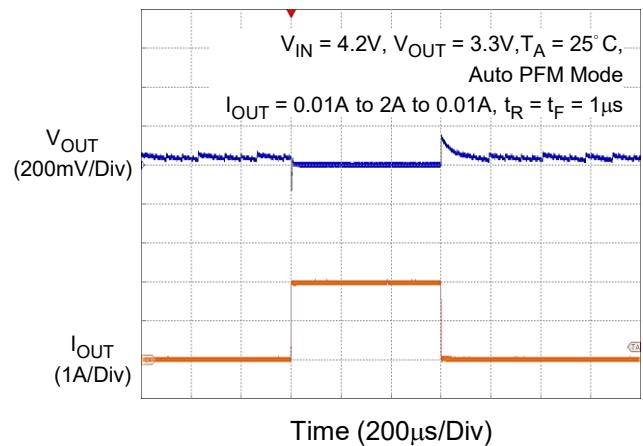
Line Transient Response (Heavy Load)



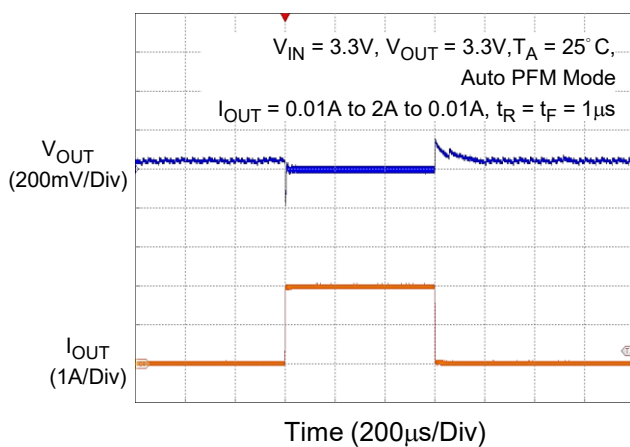
Line Transient Response (SPEC Condition)



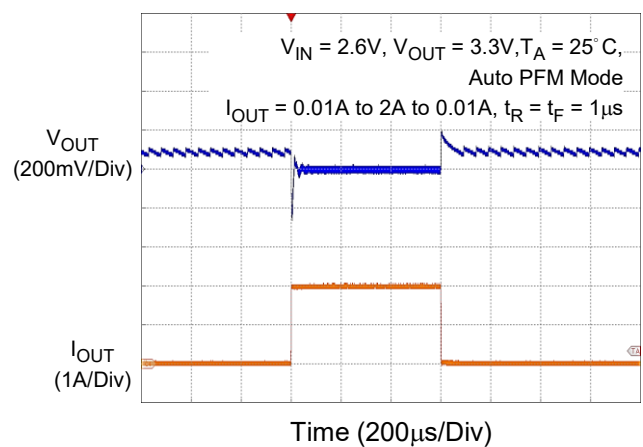
Load Transient Response (Buck)



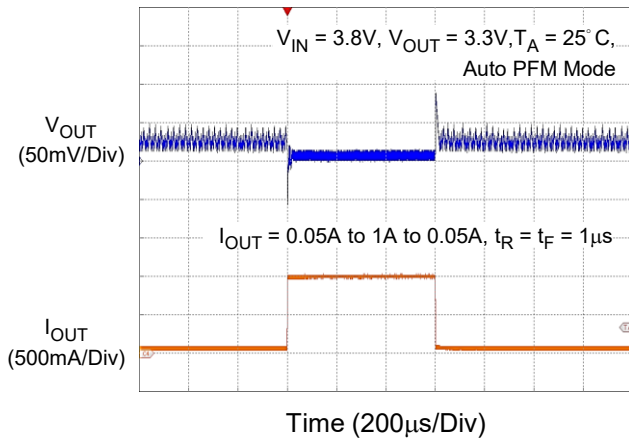
Load Transient Response (Buck-Boost)



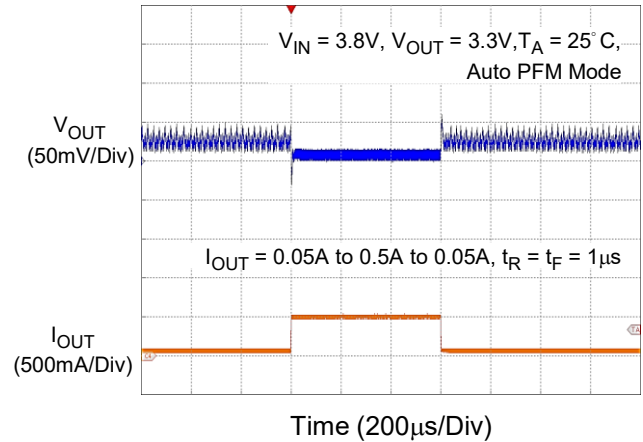
Load Transient Response (Boost)



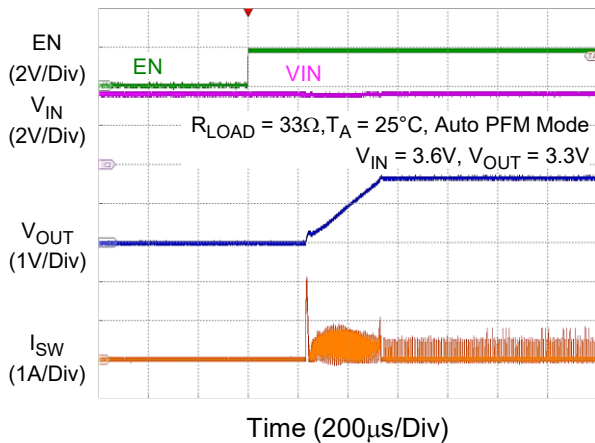
Load Transient Response (SPEC Condition1)



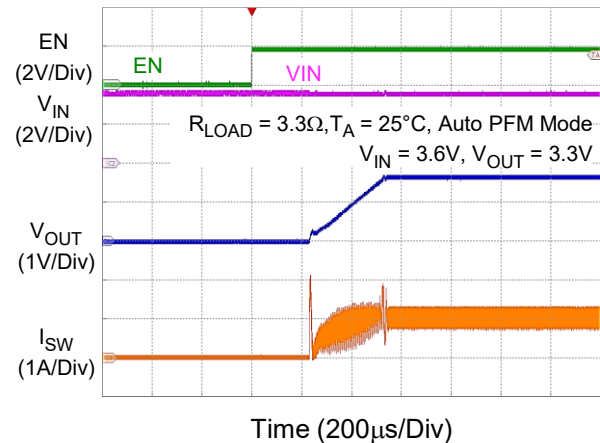
Load Transient Response (SPEC Condition2)



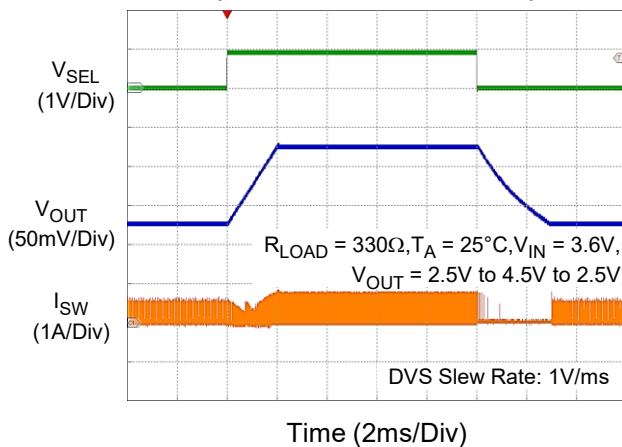
Start-Up Waveforms (Light Load)



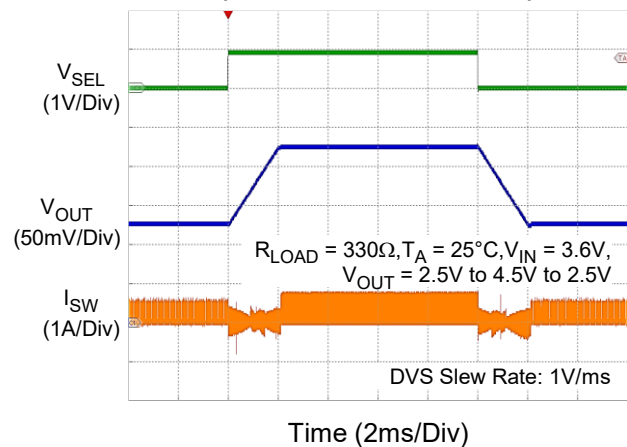
Start-Up Waveforms (Heavy Load)



Dynamic Voltage Scaling (RPWM Function Disable)

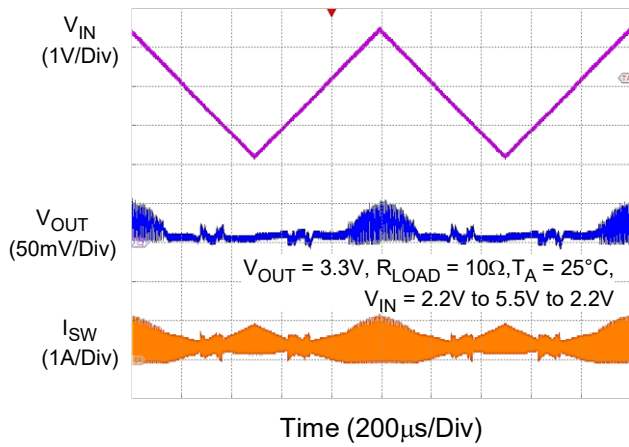


Dynamic Voltage Scaling (RPWM Function Enable)

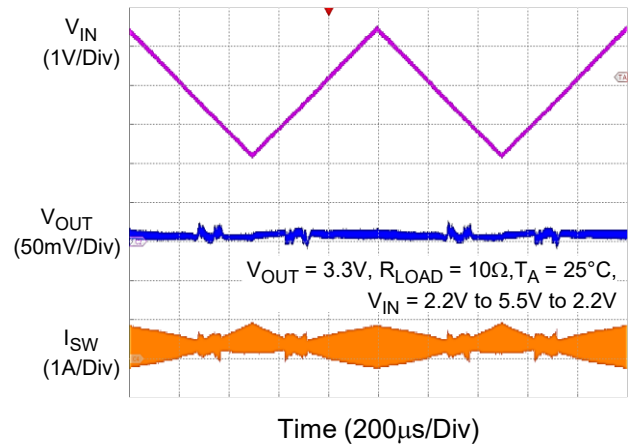




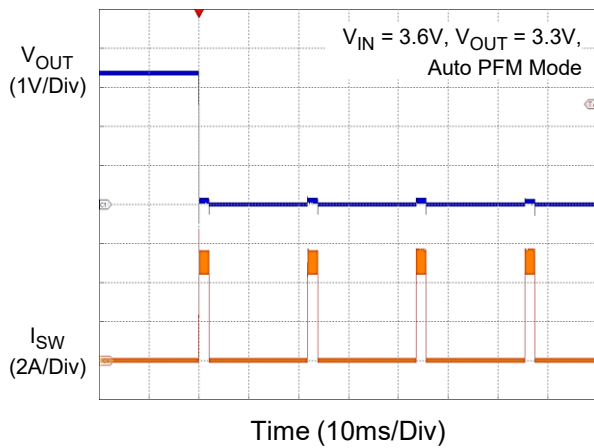
### Line Sweep (Auto PFM Mode)



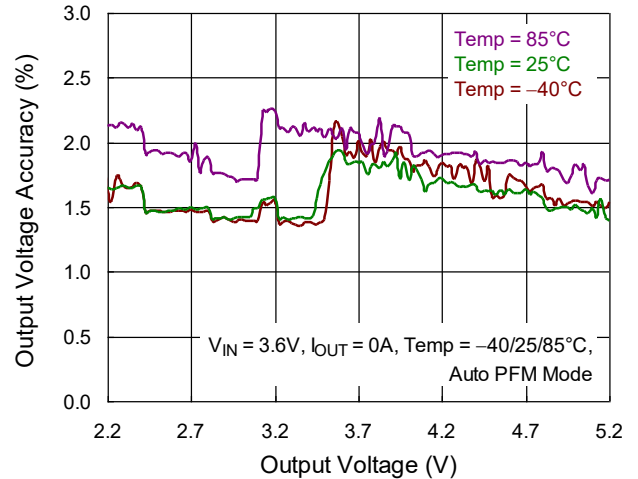
### Line Sweep (FPWM Mode)



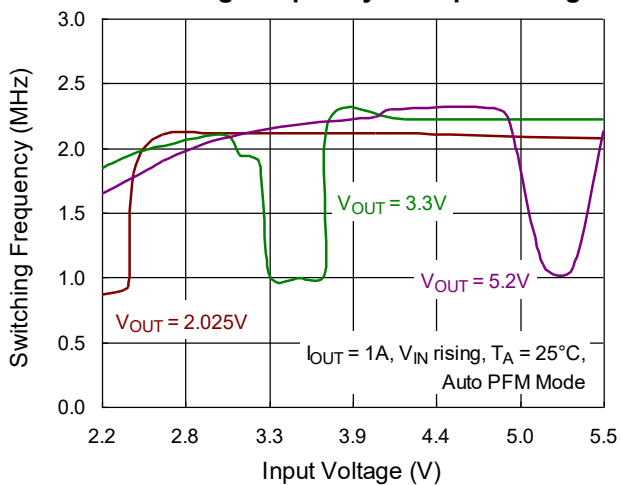
### Output Short-Circuit Behavior



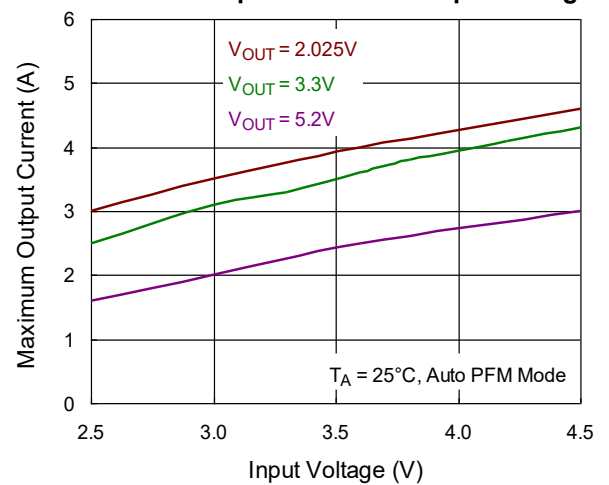
### Output Voltage Accuracy



### Switching Frequency vs. Input Voltage



### Maximum Output Current vs. Input Voltage





## 15 Operation

The RT6160B adopts a high-efficiency, single-inductor, ACOT<sup>®</sup> (Advanced Constant On-Time) mode control mechanism designed to achieve a fast transient response and good stability with low-ESR ceramic capacitors.

The ACOT<sup>®</sup> control scheme uses a virtual inductor current ramp generated inside the IC to replace the ramp normally provided by the output capacitor's ESR. The internal ramp signal and other internal compensations are optimized for low-ESR ceramic output capacitors.

### 15.1 Buck Operation

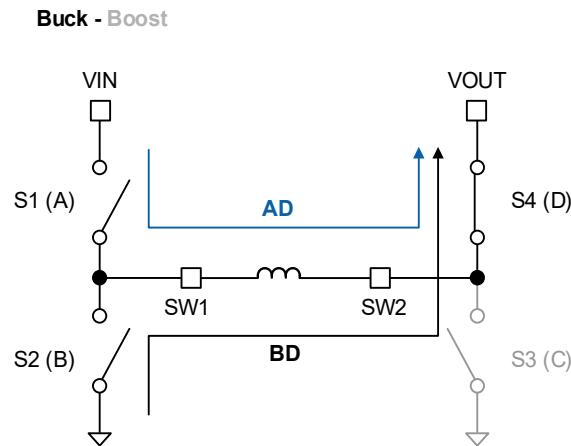


Figure 1. Buck Operation

When  $V_{IN} > V_{OUT}$ , the device operates like a buck converter. In steady-state buck-mode operation, the on-time pulse turns on the high-side switch S1, while S4 remains on, and the inductor current ramps up linearly. After the on-time period, the high-side switch S1 is turned off, and the synchronous rectifier switch S2 is turned on, while S4 remains on, and the inductor current ramps down linearly.

### 15.2 Boost Operation

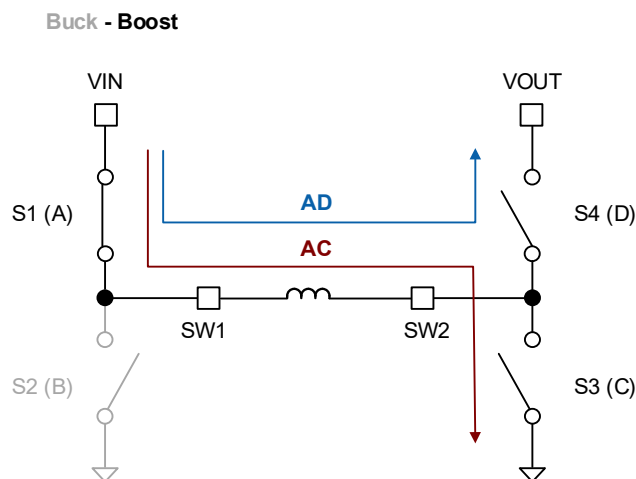


Figure 2. Boost Operation

When  $V_{IN} < V_{OUT}$ , the device operates like a boost converter. In boost mode under light load conditions, the on-time pulse turns on the S3 switch to maintain a constant on-time, while S1 remains on, and the inductor current ramps up linearly. After the on-time period, the S3 switch is turned off, and the synchronous rectifier switch S4 is turned on for a certain time, while S1 remains on, and the inductor current ramps down linearly. When the inductor current drops to zero, S4 will turn off. As the loading current increases, the device operates in CCM (continuous conduction mode), and the switches are modulated to maintain the desired output voltage. When the feedback signal is less than the reference value, the device turns on S3, while S1 remains on. After the off-time one-shot is cleared, the inductor current ramps up linearly. Then, the off-time one-shot turns on S4, while S1 remains on, and the inductor current ramps down linearly.

### 15.3 Buck-Boost Operation

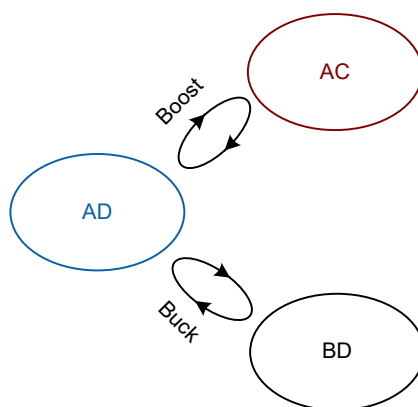


Figure 3. Buck-Boost Operation

When  $V_{IN} \approx V_{OUT}$ , all four transistors switch continuously, and the device operates in buck-boost mode. In buck-boost mode under light-load conditions, the device turns on switches S1 and S3, allowing the inductor current to increase linearly until it reaches the target peak-current level. When the inductor current reaches the peak-current level, switches S1 and S4 are turned on for a constant time, allowing the inductor current to decrease linearly. Afterward, switches S2 and S4 are turned on to ensure the inductor decreases to zero. At light-load conditions, the frequency increases as the load increases. Once the loading current is large enough, the converter will transition from boundary-conduction mode to continuous conduction mode. Furthermore, when  $V_{IN}$  is close to  $V_{OUT}$  in CCM, the switching frequency will decrease to half of the nominal switching frequency, and the device will maintain the output voltage tracking the target  $V_{OUT}$ .

## 16 Application Information

(Note 13)

The basic RT6160B application circuit is shown in the Typical Application Circuit. External component selection is determined by the maximum load current and begins with the selection of the inductor value and operating frequency followed by  $C_{IN}$  and  $C_{OUT}$ .

### 16.1 Soft-Start

An internal current source charges an internal capacitor to build the soft-start ramp voltage. During the soft-start period, the device sets  $\overline{PG}$  to “1” until  $V_{OUT}$  reaches 99% of its set voltage.

The rise time of the output voltage changes with the application circuit and the operating conditions. The rise time of the output voltage increases if:

- The load current is large
- The output capacitance is large

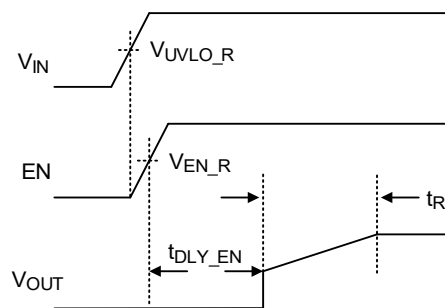


Figure 4. Soft-Start Sequence

### 16.2 Enable

The RT6160B provides an EN pin as an external chip enable control to enable or disable the device. If the EN voltage is held below the logic-high threshold ( $V_{EN\_R}$ ), switching is inhibited, even if the  $V_{IN}$  voltage is above the UVLO rising threshold voltage ( $V_{UVLO\_R}$ ). If the EN voltage is held below 0.4V, the converter will enter shutdown mode; in this state, the converter is disabled, and all registers are reset to their default values. During shutdown mode, the supply current can be reduced to  $I_{SHDN}$  ( $1\mu A$  or below). It is recommended that the  $V_{IN}$  voltage should be higher than the  $V_{IN}$  rising threshold voltage ( $V_{UVLO\_R}$ ) first. Then, when the EN voltage rises above the logic-high threshold ( $V_{EN\_R}$ ), the device will turn on, enabling switching and initiating the soft-start sequence.

Note that there is a  $100\mu s$  delay time to allow  $I^2C$  read/write operations when the EN pin goes above the logic-high threshold.

### 16.3 VSEL

- When  $VSEL = L$ , the default output voltage is 3.3V, which can be programmed via Address 0x04[6:0] in the VOUT1 register.
- When  $VSEL = H$ , the default output voltage is 3.85V, which can be programmed via Address 0x05[6:0] in the VOUT2 register.

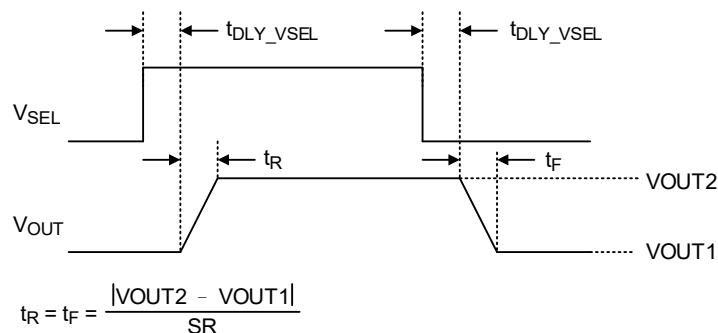


Figure 5. DVS Control the VSEL Pin

The SR in [Figure 5](#) is the slew rate set by the (DVS Slew Rate) bits in the CONTROL register.

#### 16.4 Auto Pulse Frequency Modulation Mode

In order to save power and improve efficiency at low loads, the buck/boost converter operates in PFM (Pulse Frequency Modulation) mode as the inductor drops into DCM (Discontinuous Current Mode). The switching frequency is proportional to the load to achieve output voltage regulation. When the load increases and the inductor current becomes continuous again, the buck/boost converter automatically switches back to PWM fixed frequency mode. Additionally, the RT6160B will enter DSLP (Deep Sleep) mode to achieve low input quiescent current at no load. Auto PFM Mode is the default mode.

#### 16.5 Forced Pulse Width Modulation Mode

The switching frequency is forced into PWM mode operation. In this mode, the inductor current is in CCM (Continuous Current Mode) and the voltage is regulated by PWM. To enable Forced-PWM operation, set the FPWM bit in the Control register to 1.

#### 16.6 Ultra-Sonic Mode

In order to avoid operational noise issues, the switching frequency is always designed to be higher than 30kHz, even when there is no load at the output. To enable Ultra-Sonic Mode operation, set the Ultra-Sonic Mode bit in the Control register to 1.

#### 16.7 Ramp-PWM Function

If you want the device to operate in Auto PFM mode and ensure that dynamic voltage scaling ramps the output voltage up and down in a controlled manner, enabling the Ramp-PWM function is very useful. In Ramp-PWM mode, the device operates in forced-PWM when it ramps from one output voltage to another during dynamic voltage scaling. If the device operates in Auto PFM mode and Ramp-PWM is not enabled, the device cannot control the ramp from a higher output voltage to a lower output voltage, because in Automatic PFM/PWM mode, the device cannot sink current.

To enable the Ramp-PWM function, set the RAMP bit in the Control register to 1.

To disable the Ramp-PWM function, clear the RAMP bit in the Control register to 0.

## 16.8 Dynamically Voltage Scaling Control

RT6160B supports a programmable slew-rate control feature for increasing and decreasing the output voltage, also known as DVS (Dynamically Voltage Scaling). The ramp slew-rate can be set to 1V/ms, 2.5V/ms, 5V/ms, or 10V/ms through bit 1 and bit 0 of the control register. Moreover, the operation mode during the DVS region can be adjusted through control register bit 2. When the device operates in Auto PFM/PWM mode, if bit 2 is set to 1, the device will change to Forced PWM mode operation during the DVS region and revert to auto PFM/PWM mode after reaching the target output voltage. The device will keep auto PFM/PWM mode during the DVS region if bit 2 of the control register is set to 0.

## 16.9 Output Discharge

The device actively discharges the output when the EN pin is low.

## 16.10 VOUT Selection

The RT6160B has a programmable VOUT range from 2.025V to 5.2V with a 25mV resolution. The output voltage can be set by the VOUTX register bits, and the output voltage is given by the following equation:

$$V_{OUT} = 2.025V + V_{OUTX} [6:0] \times 25mV$$

For example:

if VOUTX [6:0] = 110011 (51 decimal), then:

$$V_{OUT} = 2.025V + 51 \times 25mV = 2.025V + 1.275V = 3.3V.$$

The RT6160B also has an external VSEL pin to select VOUT1 (0X04) or VOUT2 (0X05). Pulling VSEL high selects VOUT2, and pulling VSEL low selects VOUT1. Upon power-on reset (POR), VOUT1, and VOUT2 are reset to their default voltages.

## 16.11 Power-Good Comparator

When a power-not-good condition occurs, the device sets the  $\overline{PG}$  bit in the Status register to 1. The device clears the  $\overline{PG}$  bit to 0 if you read the Status register when a power-good condition exists.

## 16.12 Auto-Zero Current Detector

The auto-zero current detector circuit senses the SW1 and SW2 waveforms to adjust the zero current threshold voltage. When the current of the low-side MOSFET decreases to the zero current threshold, the low-side MOSFET turns off to prevent negative inductor current. In this way, the zero current threshold can be adjusted for different conditions to achieve better efficiency.

## 16.13 Load Disconnect

During device shutdown, the input is disconnected from the output. This prevents any current flow from the output to the input or from the input to the output.

## 16.14 PWM Frequency and Adaptive On-Time Control

The on-time can be roughly estimated by the following equation:

$$t_{ON} = \frac{V_{OUT}}{V_{IN}} \times \frac{1}{f_{SW}}$$

where fsw is nominally 2.2MHz.

### 16.15 Inductor Selection

Choosing an inductor value will affect transient response, ripple, and other performance aspects. The RT6160B recommends a nominal inductance value of 0.47μH to achieve optimal performance.

The inductor value and operating frequency determine the ripple current according to a specific input and output voltage. The ripple current  $\Delta I_L$  increases with higher  $V_{IN}$  and decreases with higher inductance.

$$\Delta I_L = \left( \frac{V_{OUT}}{f_{SW} \times L} \right) \times \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Having a lower ripple current reduces not only the ESR losses in the output capacitors but also the output voltage ripple. High frequency with small ripple current can achieve the highest efficiency operation. However, it requires a large inductor to achieve this goal.

For the ripple current selection, the value of  $\Delta I_L$ , which is  $I_{MAX}$  multiplied by 0.3, will be a reasonable starting point.

The largest ripple current occurs at the highest  $V_{IN}$ . To guarantee that the ripple current stays below the specified maximum, the inductor value should be chosen according to the following equation:

$$L = \left( \frac{V_{OUT}}{f_{SW} \times \Delta I_L(MAX)} \right) \times \left( 1 - \frac{V_{OUT}}{V_{IN(MAX)}} \right)$$

The inductor's current rating (causing a 40°C temperature rise from a 25°C ambient) should be greater than the maximum load current, and its saturation current should be greater than the short circuit peak current limit.

### 16.16 Input Capacitor Selection

The steady-state and transient response performance also depend on input voltage stability. The RT6160B recommends using at least a 10μF input capacitor to prevent input voltage instability during operation.

It is recommended to place the capacitor as close as possible to the  $V_{IN}$  and GND pins of the IC. If the input supply is located more than a few centimeters from the device, adding some bulk capacitance to the ceramic bypass capacitors is recommended.

A 47μF electrolytic capacitor is a typical selection for the bulk capacitance.

### 16.17 Output Capacitor Selection

The ripple voltage is an important index for choosing the output capacitor. This portion consists of two parts: one is the product of ripple current with the ESR of the output capacitor, and the other part is formed by the charging and discharging process of the output capacitor. The output capacitor is selected based on the output ripple, which is calculated using the equation below:

$$\Delta V_{OUT} = \Delta V_{ESR} + \Delta V_{OUTCAP}$$

$$\Delta V_{ESR} = I_{CRMS} \times R_{CESR}$$

$$\Delta V_{OUTCAP} = \frac{I_{OUT} \times Duty}{f_{SW} \times C_{MIN}}$$

User can choose a capacitor using the equation to meet the system's ripple specifications. It is recommended to use at least two 22μF capacitors to match the application's requirements for  $V_{OUT}$  ripple and stability performance.

**Table 2. Protection Trigger Condition and Behavior**

The RT6160B features several protections, such as OCP, OVP, UVLO, OTP and UVP. The table below describes the protection actions.

| Protection Type                    | Threshold Refer to Electrical Spec.    | Deglitch Time | Protection Method                        | Reset Method                            |
|------------------------------------|--|---------------|--|---|
| OCP<br>( <a href="#">Note 12</a> ) | $I_L > 5A$                             | 0             | Turn off boost LG or<br>Turn off buck UG | $I_L < 4.5A$                            |
| UVLO                               | $V_{IN} < 2.08V$ (maximum)             | 0             | Turn off all                             | $V_{IN} > 2.17V$ (maximum)              |
| OTP                                | $TEMP > 150^{\circ}C$                  | 0             | Turn off all                             | OTP Hysteresis = $20^{\circ}C$          |
| OVP                                | $V_{OUT} > 6V$                         | 0             | Turn off all                             | $V_{OUT} < 5.6V$                        |
| UVP                                | $V_{OUT} < 0.9 \times V_{OUT\_Target}$ | 2ms           | Turn off all                             | $V_{OUT} > 0.95 \times V_{OUT\_Target}$ |

**Note 12.** Turn off all switches when OCP event occurs and is continuing for 2ms.

### 16.18 Overcurrent Protection

The Overcurrent Protection (OCP) function is implemented by UGATE and LGATE. When the inductor current reaches the UGATE current limit threshold, the high-side MOSFET will be turned-off. The low-side MOSFET turns on to discharge the inductor current until the inductor current drops below the LGATE current limit threshold. After the UGATE current limit is triggered, the maximum inductor current is determined by the inductor current rising rate and the response delay time of the internal network.

### 16.19 Input Undervoltage-Lockout Protection

In addition to the EN pin, the RT6160B also provides enable control through the VIN pin. If VEN rises above VEN\_R first, switching will still be inhibited until the VIN voltage rises above VUVLO\_R. This ensures that the internal regulator is ready, preventing operation with not-fully-enhanced internal MOSFET switches. After the device is powered up, if the VIN voltage goes below the UVLO falling threshold voltage (VUVLO\_F), switching will be inhibited. If the VIN voltage rises above the UVLO rising threshold (VUVLO\_R), the device will resume switching.

### 16.20 Over-Temperature Protection

When the junction temperature exceeds the OTP threshold value, the IC will shut down the switching operation. Once the junction temperature cools down and is lower than the OTP lower threshold, the converter will automatically resume switching. When the device detects an over-temperature condition, it sets the TSD bit in the Status register to 1. The device clears the TSD bit to 0 if you read the Status register when the junction temperature of the device is less than  $130^{\circ}C$ .

### 16.21 Overvoltage Protection

When the VOUT pin is floating, the device will trigger overvoltage protection to prevent the output voltage from exceeding critical values. If the output reaches the OVP threshold, the device will regulate the voltage to maintain it at this threshold value.

### 16.22 Undervoltage Protection

The RT6160B provides Hiccup Mode for Undervoltage Protection (UVP). When the VOUT voltage drops below 90% of the target VOUT, the UVP function will be triggered to shut down switching operation. If the UVP condition remains for a period, the RT6160B will retry to build up the output voltage automatically. When the UVP condition is removed, the converter will soft-start to the target voltage and resume normal operation.

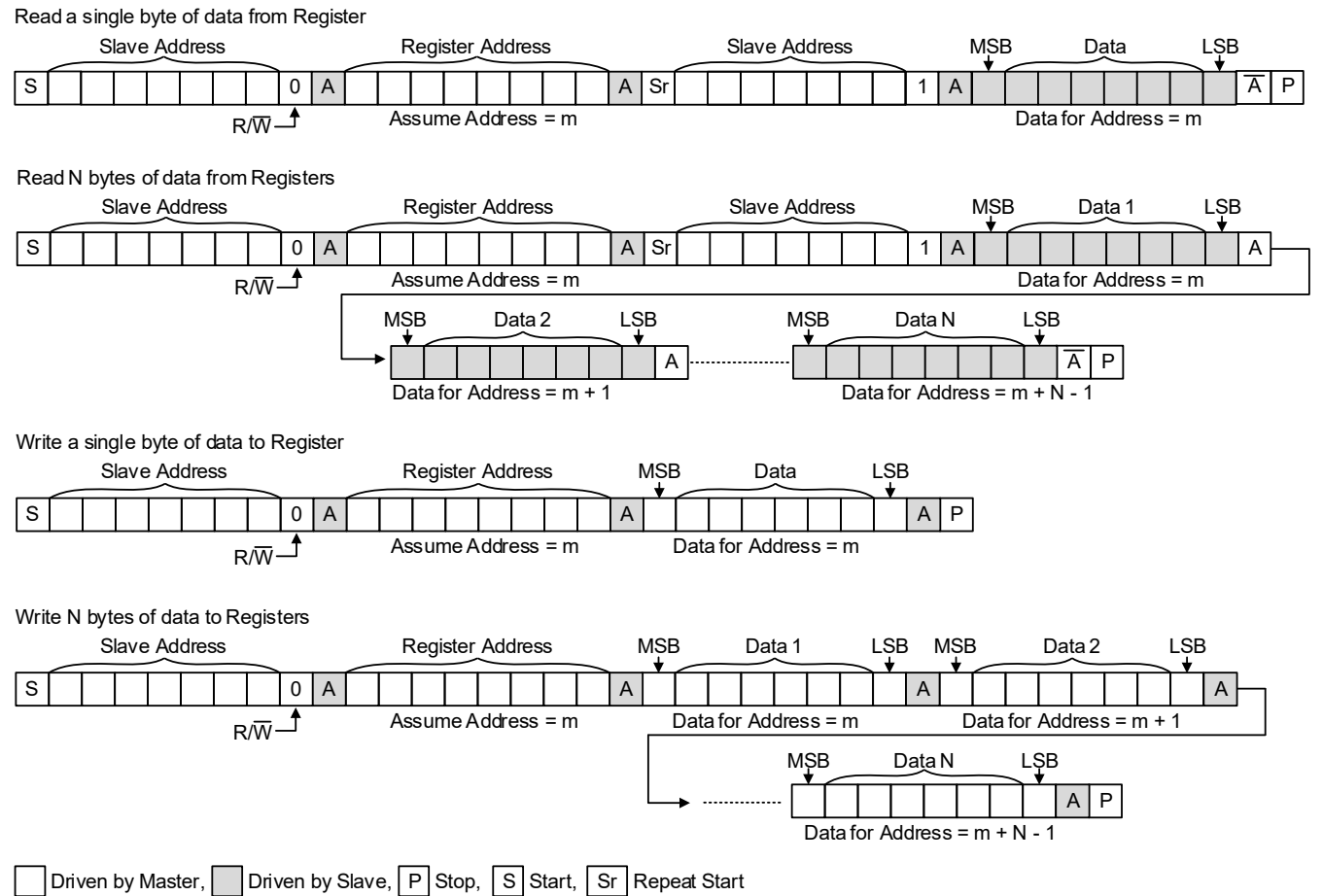
16.23 I<sup>2</sup>C Interface

The following table shows the RT6160B slave address 0x75(7bit).

| RT6160B I <sup>2</sup> C Slave Address (75H) |     |         |       |
|--|-----|---------|-------|
| MSB  | LSB | R/W bit | R/W   |
| 111010                                       | 1   | 1/0     | EB/EA |

The I<sup>2</sup>C interface bus must be connected to a 2.2kΩ resistor to the power node and independently connected to the processor. The I<sup>2</sup>C timing diagrams are listed below.

16.23.1 Read and Write Function



16.23.2 I<sup>2</sup>C Waveform Information

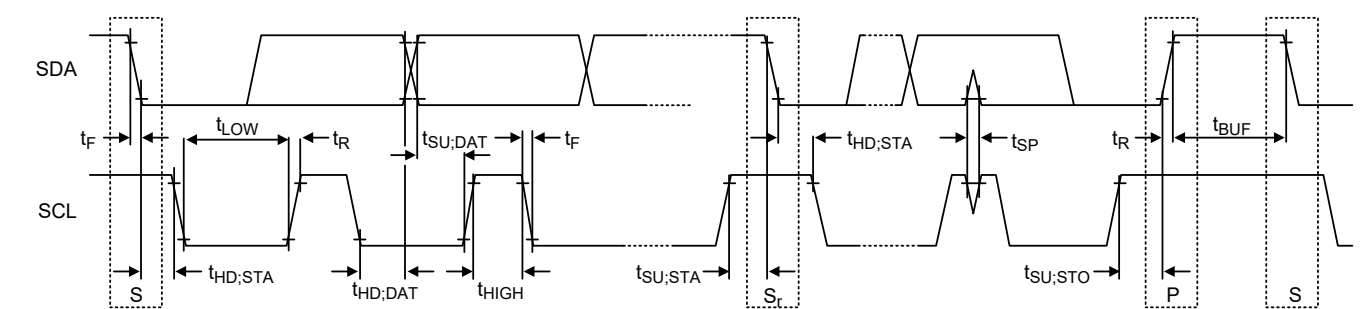


Figure 6. I<sup>2</sup>C Read and Write Stream and Timing Diagram



## 16.24 Thermal Considerations

The junction temperature should never exceed the absolute maximum junction temperature  $T_{J(MAX)}$ , listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction-to-ambient thermal resistance.

For continuous operation, the maximum operating junction temperature indicated under Recommended Operating Conditions is 125°C. The junction-to-ambient thermal resistance,  $\theta_{JA}$ , is highly package dependent. For a WL-CSP-15B 1.4x2.3 (BSC) package, the thermal

resistance,  $\theta_{JA}$ , is 53°C/W on a standard JEDEC 51-7 high effective-thermal conductivity four-layer test board. The maximum power dissipation at  $T_A = 25^\circ\text{C}$  can be calculated as below:

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / (53^\circ\text{C/W}) = 1.88\text{W for a WL-CSP-15B 1.4x2.3 package.}$$

The maximum power dissipation depends on the operating ambient temperature for the fixed  $T_{J(MAX)}$  and the thermal resistance,  $\theta_{JA}$ . The derating curve in [Figure 7](#) allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

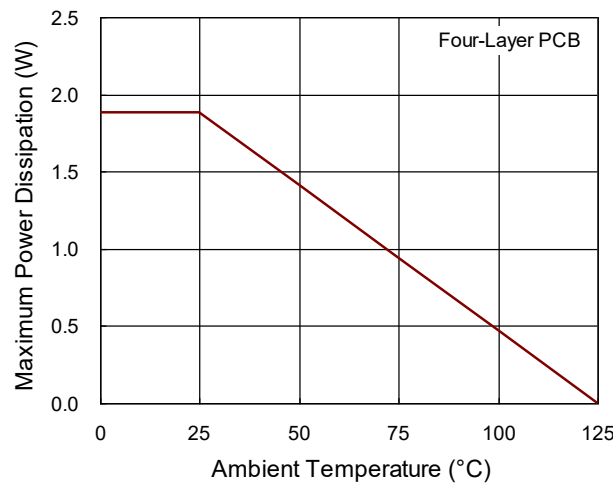


Figure 7. Derating Curve of Maximum Power Dissipation

## 16.25 Layout Considerations

For the best performance of the RT6160B, the following layout guidelines must be strictly followed:

- The input capacitor must be placed as close as possible to the IC to minimize the power loop area. A typical  $0.1\mu\text{F}$  decoupling capacitor is recommended to reduce the power loop area and any high-frequency components on VIN.
- The switching nodes (SW1 and SW2) have high-frequency voltage swings and should be kept at a small area. Keep analog components away from the SW1 and SW2 nodes to prevent stray capacitive noise pickup.
- Keep every power trace connected to the pin as wide as possible to improve thermal dissipation.
- The AGND pin is suggested to be connected to the 2<sup>nd</sup> GND plane through a via from the top to the 2<sup>nd</sup> layer.

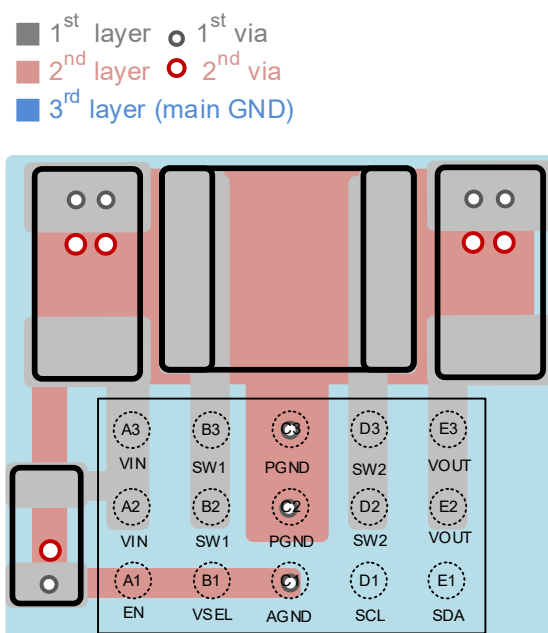


Figure 8. Layout Guide

1. The loop from VIN to CIN to PGND should be as short as possible to reduce the switching noise in buck mode.
2. The loop from VOUT to COUT to PGND should be as short as possible to reduce the switching noise in boost mode.
3. The loop from VIN to AGND should be separated from the PGND loop to reduce noise.
4. Connect AGND directly to C3 or C2 to reduce noise.

**Note 13.** The information provided in this section is for reference only. The customer is solely responsible for designing, validating, and testing any applications incorporating Richtek's product(s). The customer is also responsible for applicable standards and any safety, security, or other requirements.

## 17 Functional Register Description

### 17.1 Register Table List

| Name    | Address | Description   |
|---------|---------|---|
| CONTROL | 0x01    | Output pull-down slew rate control<br>MODE function control<br>DVS slew rate function control |
| STATUS  | 0x02    | Read IC status  |
| DEVID   | 0x03    | Device identity   |
| VOUT1   | 0x04    | Output voltage 1 when the VSEL pin is low   |
| VOUT2   | 0x05    | Output voltage 2 when the VSEL pin is high  |

### 17.2 Register Description

I<sup>2</sup>C Slave address = 1110101 (75H)

I<sup>2</sup>C Register Map

R: Read Only

RW: Read and Write

| Address 0x01 | CONTROL      |                           |     |                  |            |          |               |                        |
|--------------|--------------|---------------------------|-----|------------------|------------|----------|---------------|------------------------|
| Bits         | 7            | 6                         | 5   | 4                | 3          | 2        | 1             | 0                      |
| Name         | Reserved     | I <sup>2</sup> C_SDA_SLEW |     | Ultra-Sonic Mode | Forced PWM | Ramp PWM | DVS Slew Rate |                        |
| Reset        | 0            | 0                         | 0   | 0                | 0          | 0        | 0             | 0                      |
| Type         | R            | R/W                       | R/W | R/W              | R/W        | R/W      | R/W           | R/W                    |
| Address 0x02 | STATUS       |                           |     |                  |            |          |               |                        |
| Bits         | 7            | 6                         | 5   | 4                | 3          | 2        | 1             | 0                      |
| Name         | Reserved     |                           |     | HD               | UV         | OC       | TSD           | $\overline{\text{PG}}$ |
| Reset        | 0            | 0                         | 0   | 0                | 0          | 0        | 0             | 0                      |
| Type         | R            | R                         | R   | R                | R          | R        | R             | R                      |
| Address 0x03 | DEVID        |                           |     |                  |            |          |               |                        |
| Bits         | 7            | 6                         | 5   | 4                | 3          | 2        | 1             | 0                      |
| Name         | Manufacturer |                           |     |                  | Major      |          | Minor         |                        |
| Reset        | 1            | 0                         | 1   | 0                | 1          | 0        | 1             | 1                      |
| Type         | R            | R                         | R   | R                | R          | R        | R             | R                      |
| Address 0x04 | VOUT1        |                           |     |                  |            |          |               |                        |
| Bits         | 7            | 6                         | 5   | 4                | 3          | 2        | 1             | 0                      |
| Name         | Reserved     | VOUT1                     |     |                  |            |          |               |                        |
| Reset        | 0            | 0                         | 1   | 1                | 0          | 0        | 1             | 1                      |
| Type         | R            | R/W                       | R/W | R/W              | R/W        | R/W      | R/W           | R/W                    |
| Address 0x05 | VOUT2        |                           |     |                  |            |          |               |                        |
| Bits         | 7            | 6                         | 5   | 4                | 3          | 2        | 1             | 0                      |
| Name         | Reserved     | VOUT2                     |     |                  |            |          |               |                        |
| Reset        | 0            | 1                         | 0   | 0                | 1          | 0        | 0             | 1                      |
| Type         | R            | R/W                       | R/W | R/W              | R/W        | R/W      | R/W           | R/W                    |

| Address | Register Name | Bit | Bit Name                  | Default | Type | Description  |
|---------|---------------|-----|---------------------------|---------|------|--|
| 0x01    | CONTROL       | 7   | Reserved                  | 0       | R    | Reserved   |
|         |               | 6:5 | I <sup>2</sup> C_SDA_SLEW | 00      | R/W  | SDA pin output pull-down slew rate<br>00: High (default)<br>01: Medium<br>10: Low<br>11: Very low  |
|         |               | 4   | Ultra-Sonic Mode          | 0       | R/W  | This bit controls the ultra-sonic mode function.<br>0: Ultra-Sonic mode disabled (default)<br>1: Ultra-Sonic mode enabled                |
|         |               | 3   | Forced PWM                | 0       | R/W  | This bit controls the forced-PWM mode function.<br>0: Forced PWM operation disabled (default)<br>1: Forced PWM operation enabled         |
|         |               | 2   | Ramp PWM                  | 0       | R/W  | This bit controls the ramp-PWM function.<br>0: Ramp-PWM operation disabled (default)<br>1: Ramp-PWM operation enabled                    |
|         |               | 1:0 | DVS Slew Rate             | 00      | R/W  | These bits control the slew rate of the DVS function.<br>00: 1.0V/ms (default)<br>01: 2.5V/ms<br>10: 5.0V/ms<br>11: 10.0V/ms             |
| 0x02    | STATUS        | 7:5 | Reserved                  | 000     | R    | Reserved   |
|         |               | 4   | HD                        | 0       | R    | This bit shows the status of the hot-die function.<br>0: Normal operation (default)<br>1: A hot-die event is detected                    |
|         |               | 3   | UV                        | 0       | R    | This bit shows the status of the undervoltage function.<br>0: Normal operation (default)<br>1: An undervoltage event is detected         |
|         |               | 2   | OC                        | 0       | R    | This bit shows the status of the overcurrent function.<br>0: Normal operation (default)<br>1: An overcurrent event is detected           |
|         |               | 1   | TSD                       | 0       | R    | This bit shows the status of the thermal shutdown function.<br>0: Temperature good (default)<br>1: An over-temperature event is detected |
|         |               | 0   | $\overline{\text{PG}}$    | 0       | R    | This bit shows the status of the power-good comparator.<br>0: Power-good (default)<br>1: A power-not-good is detected                    |

| Address | Register Name | Bit | Bit Name     | Default | Type | Description   |
|---------|---------------|-----|--------------|---------|------|---|
| 0x03    | DEVID         | 7:4 | Manufacturer | 1010    | R    | These bits identify the device manufacturer.<br>1010: Richtek (default)   |
|         |               | 3:2 | Major        | 10      | R    | These bits identify the major silicon revision.<br>00: A (initial silicon)<br>01: B (first major revision)<br>10: C (second major revision) (default)<br>11: D (third major revision)   |
|         |               | 1:0 | Minor        | 11      | R    | These bits identify the minor silicon revision.<br>00: 0 (initial silicon)<br>01: 1 (first minor revision)<br>10: 2 (second minor revision)<br>11: 3 (third minor revision) (default)   |
| 0x04    | VOUT1         | 7   | Reserved     | 0       | R    | Reserved  |
|         |               | 6:0 | VOUT1        | 0110011 | R/W  | These bits set the output voltage when the VSEL pin is low.<br>0000000: V <sub>OUT</sub> = 2.025V<br>0000001: V <sub>OUT</sub> = 2.05V<br>0000010: V <sub>OUT</sub> = 2.075V<br>...<br>0110011: V <sub>OUT</sub> = 3.3V (default)<br>...<br>1111101: V <sub>OUT</sub> = 5.15V<br>1111110: V <sub>OUT</sub> = 5.175V<br>1111111: V <sub>OUT</sub> = 5.2V   |
| 0x05    | VOUT2         | 7   | Reserved     | 0       | R    | Reserved  |
|         |               | 6:0 | VOUT2        | 1001001 | R/W  | These bits set the output voltage when the VSEL pin is high.<br>0000000: V <sub>OUT</sub> = 2.025V<br>0000001: V <sub>OUT</sub> = 2.05V<br>0000010: V <sub>OUT</sub> = 2.075V<br>...<br>1001001: V <sub>OUT</sub> = 3.85V (default)<br>...<br>1111101: V <sub>OUT</sub> = 5.15V<br>1111110: V <sub>OUT</sub> = 5.175V<br>1111111: V <sub>OUT</sub> = 5.2V |

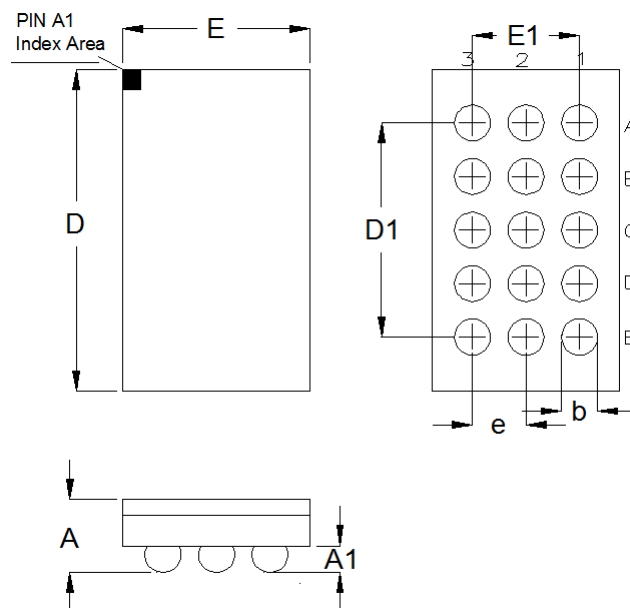
Table 3. Register VOUT1/VOUT2[6:0] vs. Output Voltage

VOUT1 Address = 0x04, Output Voltage 1 when the VSEL pin is low.

VOUT2 Address = 0x05, Output Voltage 2 when the VSEL pin is high.

| Register<br>VOUT[6:0] | Output<br>Voltage (V) | Register<br>VOUT[6:0] | Output<br>Voltage (V) | Register<br>VOUT[6:0] | Output<br>Voltage (V) | Register<br>VOUT[6:0] | Output<br>Voltage (V) |
|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|
| 0000000               | 2.025                 | 0100000               | 2.825                 | 1000000               | 3.625                 | 1100000               | 4.425                 |
| 0000001               | 2.05                  | 0100001               | 2.85                  | 1000001               | 3.65                  | 1100001               | 4.45                  |
| 0000010               | 2.075                 | 0100010               | 2.875                 | 1000010               | 3.675                 | 1100010               | 4.475                 |
| 0000011               | 2.1                   | 0100011               | 2.9                   | 1000011               | 3.7                   | 1100011               | 4.5                   |
| 0000100               | 2.125                 | 0100100               | 2.925                 | 1000100               | 3.725                 | 1100100               | 4.525                 |
| 0000101               | 2.15                  | 0100101               | 2.95                  | 1000101               | 3.75                  | 1100101               | 4.55                  |
| 0000110               | 2.175                 | 0100110               | 2.975                 | 1000110               | 3.775                 | 1100110               | 4.575                 |
| 0000111               | 2.2                   | 0100111               | 3                     | 1000111               | 3.8                   | 1100111               | 4.6                   |
| 0001000               | 2.225                 | 0101000               | 3.025                 | 1001000               | 3.825                 | 1101000               | 4.625                 |
| 0001001               | 2.25                  | 0101001               | 3.05                  | 1001001               | 3.85                  | 1101001               | 4.65                  |
| 0001010               | 2.275                 | 0101010               | 3.075                 | 1001010               | 3.875                 | 1101010               | 4.675                 |
| 0001011               | 2.3                   | 0101011               | 3.1                   | 1001011               | 3.9                   | 1101011               | 4.7                   |
| 0001100               | 2.325                 | 0101100               | 3.125                 | 1001100               | 3.925                 | 1101100               | 4.725                 |
| 0001101               | 2.35                  | 0101101               | 3.15                  | 1001101               | 3.95                  | 1101101               | 4.75                  |
| 0001110               | 2.375                 | 0101110               | 3.175                 | 1001110               | 3.975                 | 1101110               | 4.775                 |
| 0001111               | 2.4                   | 0101111               | 3.2                   | 1001111               | 4                     | 1101111               | 4.8                   |
| 0010000               | 2.425                 | 0110000               | 3.225                 | 1010000               | 4.025                 | 1110000               | 4.825                 |
| 0010001               | 2.45                  | 0110001               | 3.25                  | 1010001               | 4.05                  | 1110001               | 4.85                  |
| 0010010               | 2.475                 | 0110010               | 3.275                 | 1010010               | 4.075                 | 1110010               | 4.875                 |
| 0010011               | 2.5                   | 0110011               | 3.3                   | 1010011               | 4.1                   | 1110011               | 4.9                   |
| 0010100               | 2.525                 | 0110100               | 3.325                 | 1010100               | 4.125                 | 1110100               | 4.925                 |
| 0010101               | 2.55                  | 0110101               | 3.35                  | 1010101               | 4.15                  | 1110101               | 4.95                  |
| 0010110               | 2.575                 | 0110110               | 3.375                 | 1010110               | 4.175                 | 1110110               | 4.975                 |
| 0010111               | 2.6                   | 0110111               | 3.4                   | 1010111               | 4.2                   | 1110111               | 5                     |
| 0011000               | 2.625                 | 0111000               | 3.425                 | 1011000               | 4.225                 | 1111000               | 5.025                 |
| 0011001               | 2.65                  | 0111001               | 3.45                  | 1011001               | 4.25                  | 1111001               | 5.05                  |
| 0011010               | 2.675                 | 0111010               | 3.475                 | 1011010               | 4.275                 | 1111010               | 5.075                 |
| 0011011               | 2.7                   | 0111011               | 3.5                   | 1011011               | 4.3                   | 1111011               | 5.1                   |
| 0011100               | 2.725                 | 0111100               | 3.525                 | 1011100               | 4.325                 | 1111100               | 5.125                 |
| 0011101               | 2.75                  | 0111101               | 3.55                  | 1011101               | 4.35                  | 1111101               | 5.15                  |
| 0011110               | 2.775                 | 0111110               | 3.575                 | 1011110               | 4.375                 | 1111110               | 5.175                 |
| 0011111               | 2.8                   | 0111111               | 3.6                   | 1011111               | 4.4                   | 1111111               | 5.2                   |

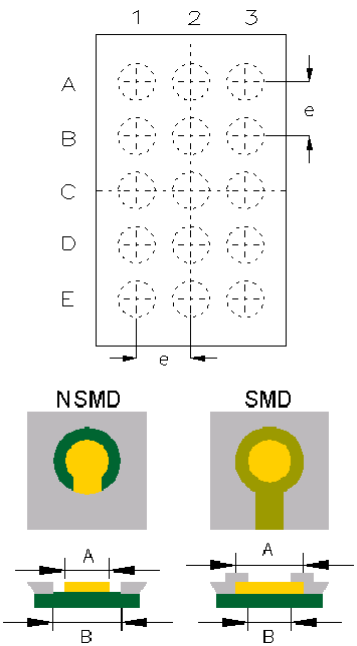
# 18 Outline Dimension



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 0.500                     | 0.600 | 0.020                | 0.024 |
| A1     | 0.170                     | 0.230 | 0.007                | 0.009 |
| b      | 0.240                     | 0.300 | 0.009                | 0.012 |
| D      | 2.260                     | 2.340 | 0.089                | 0.092 |
| D1     | 1.600                     |       | 0.063                |       |
| E      | 1.360                     | 1.440 | 0.054                | 0.057 |
| E1     | 0.800                     |       | 0.031                |       |
| e      | 0.400                     |       | 0.016                |       |

15B WL-CSP 1.4x2.3 Package (BSC)

19 Footprint Information

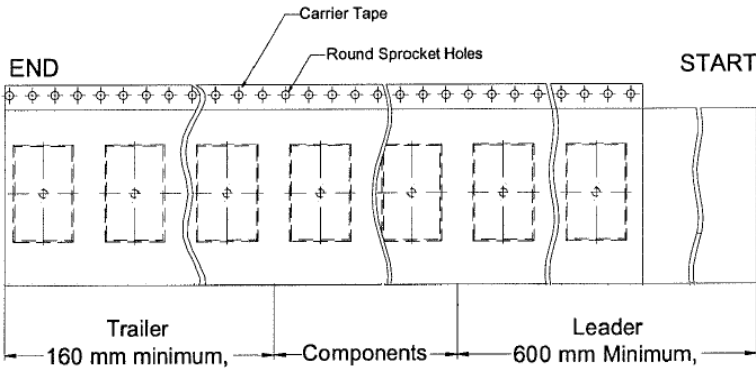
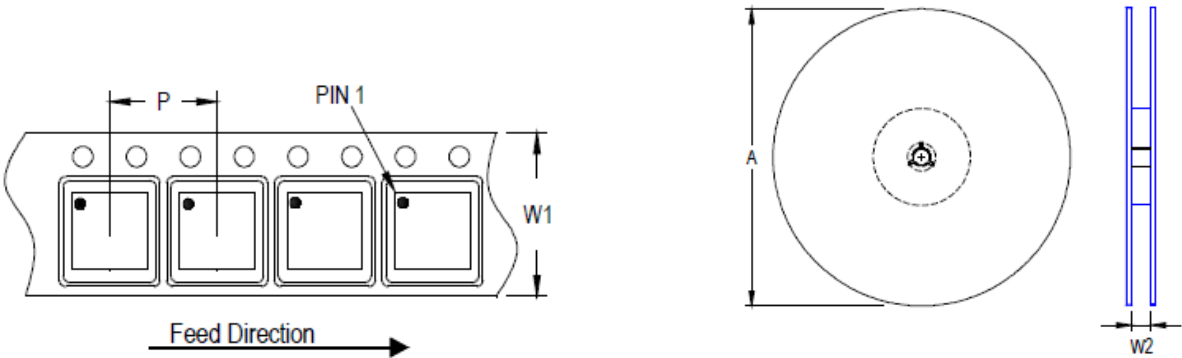


| Package               | Number of Pin | Type | Footprint Dimension (mm) |       |       | Tolerance |
|-----------------------|---------------|------|--------------------------|-------|-------|-----------|
|                       |               |      | e                        | A     | B     |           |
| WL-CSP1.4x2.3-15(BSC) | 15            | NSMD | 0.400                    | 0.240 | 0.340 | ±0.025    |
|                       |               | SMD  |                          | 0.270 | 0.240 |           |

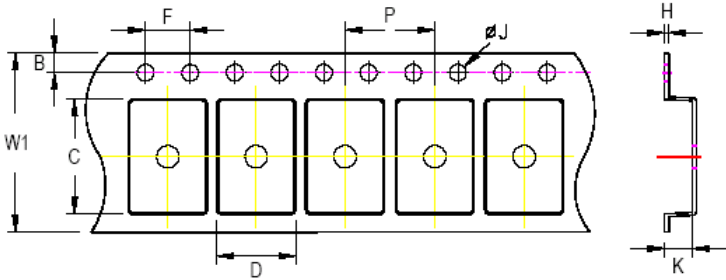


# 20 Packing Information

## 20.1 Tape and Reel Data








| Package Type   | Tape Size (W1) (mm) | Pocket Pitch (P) (mm) | Reel Size (A) |      | Units per Reel | Trailer (mm) | Leader (mm) | Reel Width (W2) Min/Max (mm) |
|----------------|---------------------|-----------------------|---------------|------|----------------|--------------|-------------|------------------------------|
|                |                     |                       | (mm)          | (in) |                |              |             |                              |
| WL-CSP 1.4x2.3 | 8                   | 4                     | 180           | 7    | 3,000          | 160          | 600         | 8.4/9.9                      |



**C, D, and K are determined by component size.**  
**The clearance between the components and the cavity is as follows:**  
**- For 8mm carrier tape: 0.5mm max.**

| Tape Size | W1    | P     |       | B      |        | F     |       | ØJ    |       | K     |       | H     |
|-----------|-------|-------|-------|--------|--------|-------|-------|-------|-------|-------|-------|-------|
|           | Max   | Min   | Max   | Min    | Max    | Min   | Max   | Min   | Max   | Min   | Max   | Max   |
| 8mm       | 8.3mm | 3.9mm | 4.1mm | 1.65mm | 1.85mm | 3.9mm | 4.1mm | 1.5mm | 1.6mm | 0.7mm | 0.8mm | 0.6mm |

20.2 Tape and Reel Packing

| Step | Photo/Description   | Step | Photo/Description   |
|------|---|------|---|
| 1    | <br>Reel 7"                              | 4    | <br>12 inner boxes per outer box |
| 2    | <br>Packing by Anti-Static Bag          | 5    | <br>Outer box <b>Carton A</b>   |
| 3    | <br>3 reels per inner box <b>Box A</b> | 6    |   |

| Container<br>Package | Reel |       | Box   |       |       | Carton                        |       |         |
|----------------------|------|-------|-------|-------|-------|-------------------------------|-------|---------|
|                      | Size | Units | Item  | Reels | Units | Item                          | Boxes | Unit    |
| WL-CSP<br>1.4x2.3    | 7"   | 3,000 | Box A | 3     | 9,000 | Carton A                      | 12    | 108,000 |
|                      |      |       | Box E | 1     | 3,000 | For Combined or Partial Reel. |       |         |

**20.3 Packing Material Anti-ESD Property**

| Surface Resistance   | Aluminum Bag        | Reel                | Cover tape          | Carrier tape        | Tube                | Protection Band     |
|----------------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|
| $\Omega/\text{cm}^2$ | $10^4$ to $10^{11}$ | $10^4$ to $10^{11}$ | $10^4$ to $10^{11}$ | $10^4$ to $10^{11}$ | $10^4$ to $10^{11}$ | $10^4$ to $10^{11}$ |

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## 21 Datasheet Revision History

| Version | Date       | Description   |
|---------|------------|---|
| 01      | 2023/7/7   | Ordering Information on P2<br>Electrical Characteristics on P5<br>Application Information on P16<br>Packing Information on P29, 30, 31  |
| 02      | 2025/11/12 | <i>Changed the name of pin B2 and pin B3 to SW1; pin D2 and pin D3 to SW2.</i><br><i>Application Information on page 26</i><br>- Modified layout guide<br><i>Packing Information on page 33</i><br>- Updated Tape and Reel Data |